

# SEMICONDUCTOR DEVICES

## MOS Transistors: Part 2

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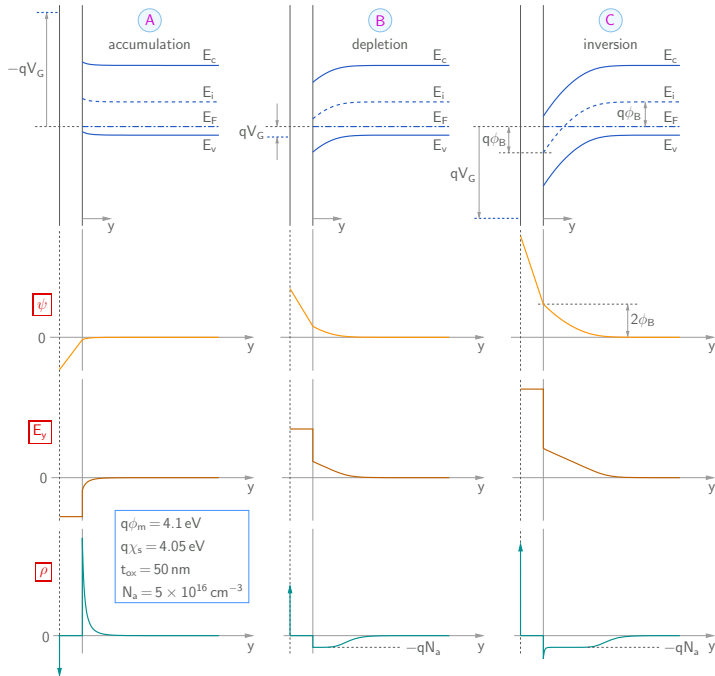
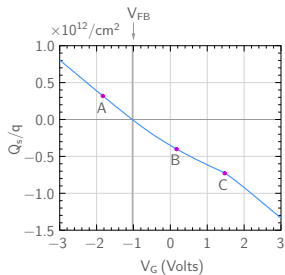
M. B. Patil

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[www.ee.iitb.ac.in/~sequel](http://www.ee.iitb.ac.in/~sequel)

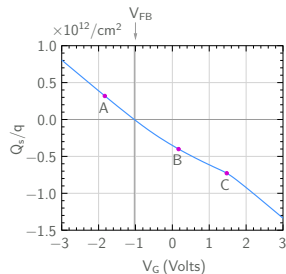
Department of Electrical Engineering  
Indian Institute of Technology Bombay

# MOS capacitor

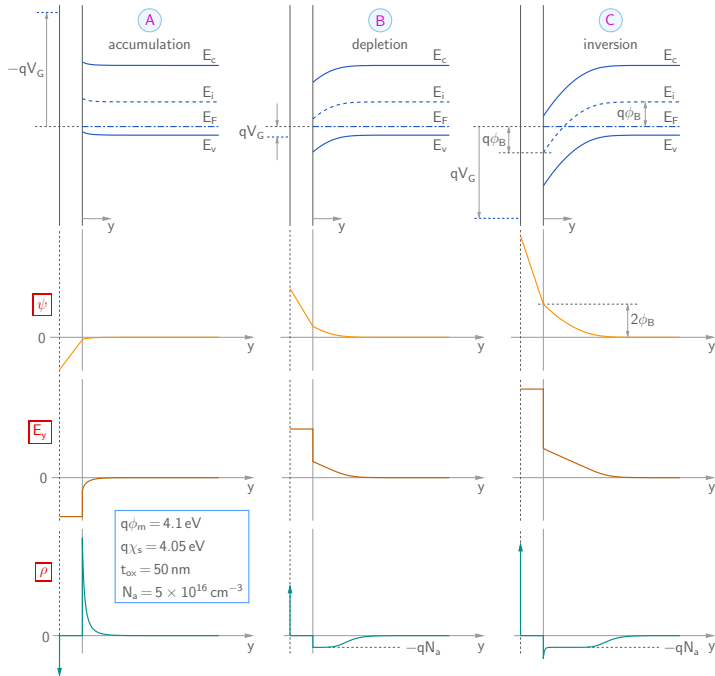


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$$* Q_s/q = \int_0^\infty (N_d^+ - N_a^- + p - n) dy.$$



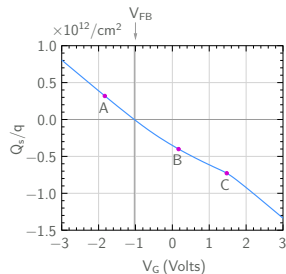
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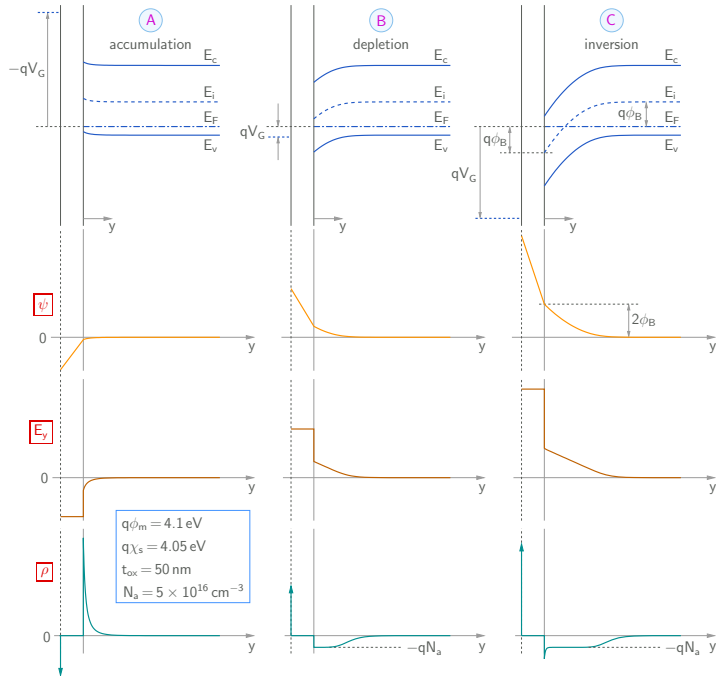
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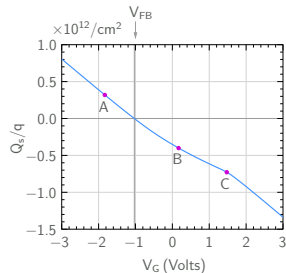


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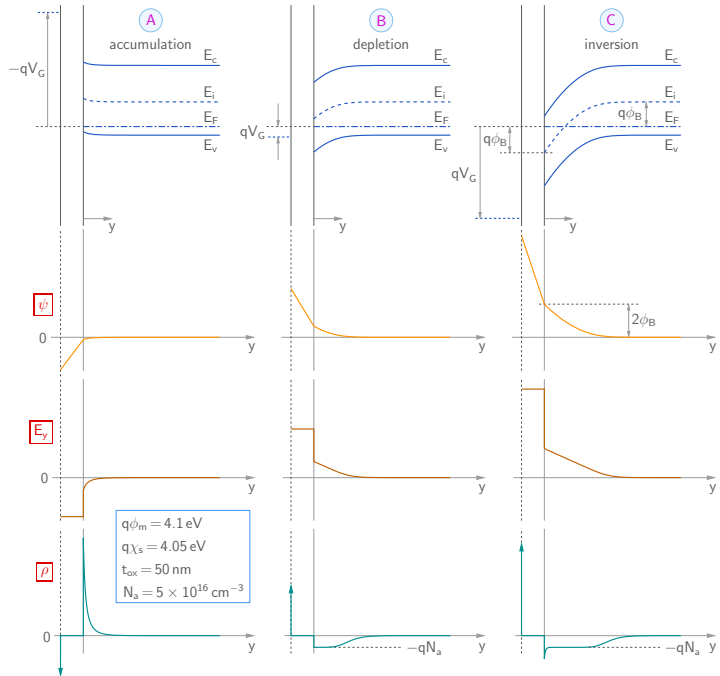


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- \*  $V_G < V_{FB} \rightarrow$  accumulation  
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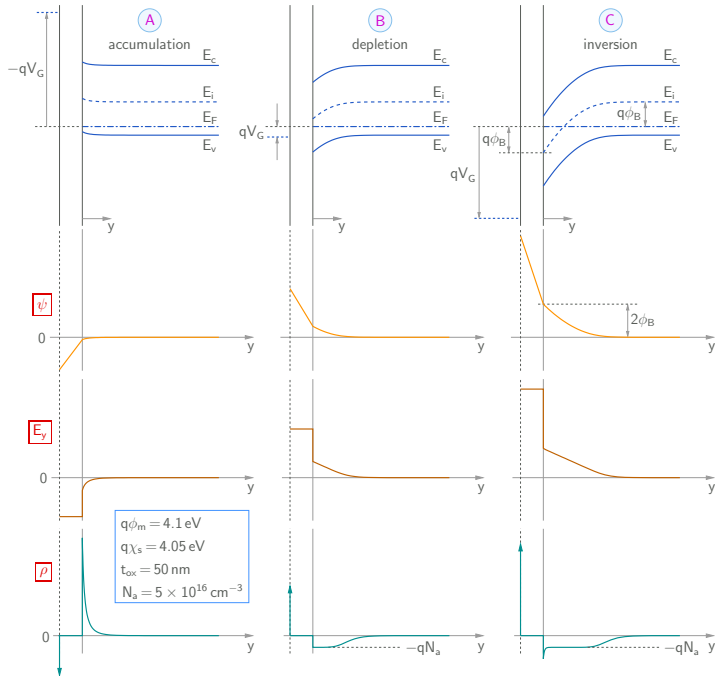
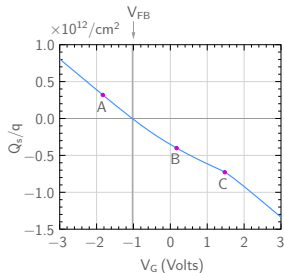


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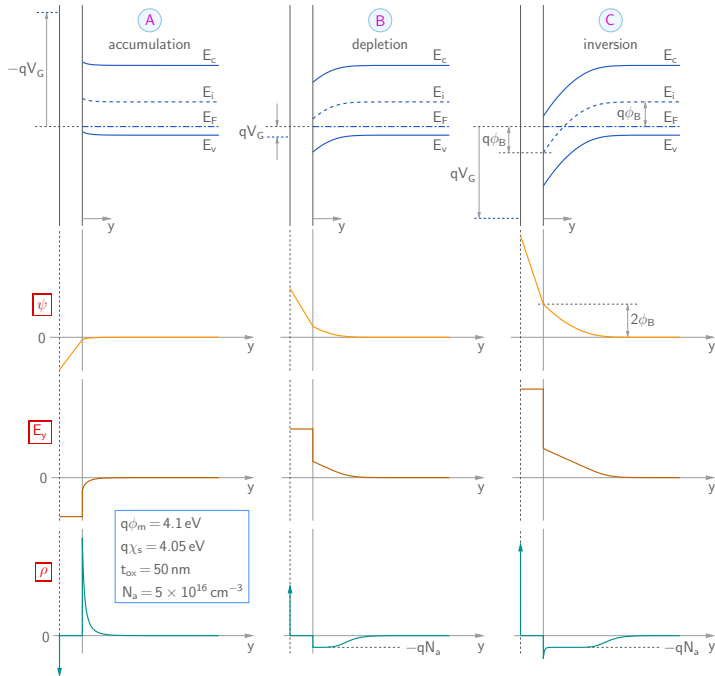
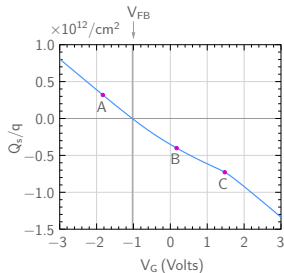
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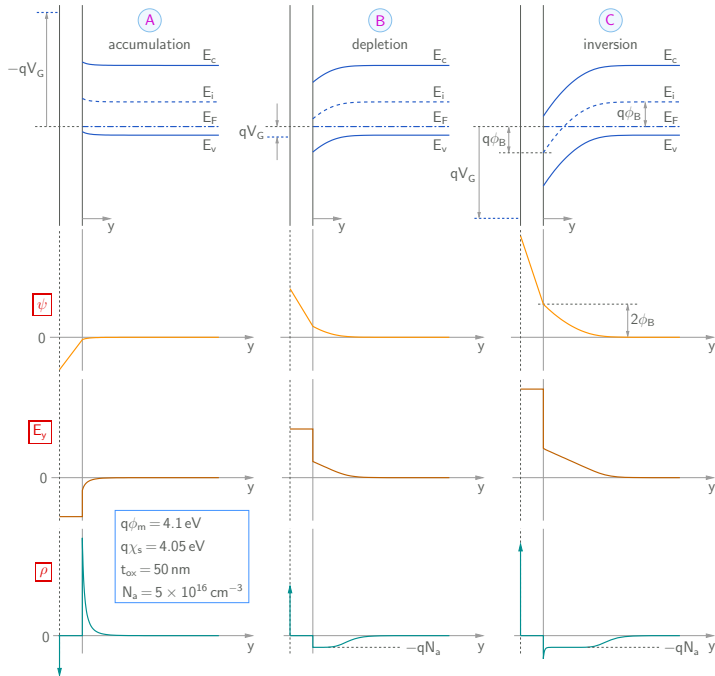
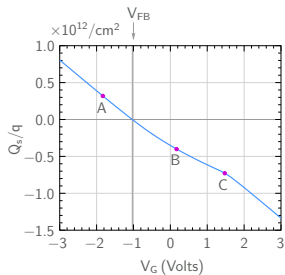


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- \* Home work: Sketch  $\rho$  versus  $y$  for the case of an  $n$ -type substrate.



# MOS capacitor

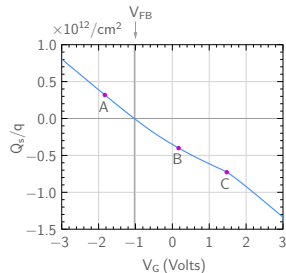




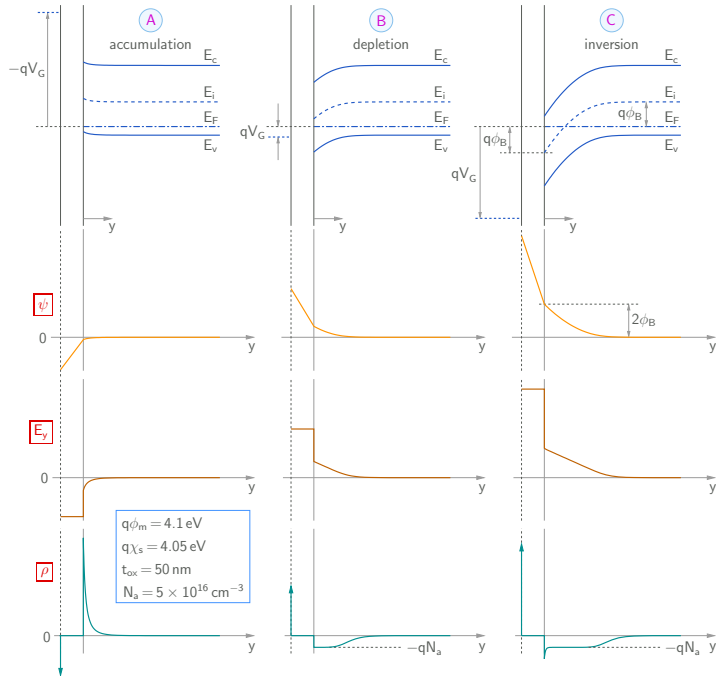
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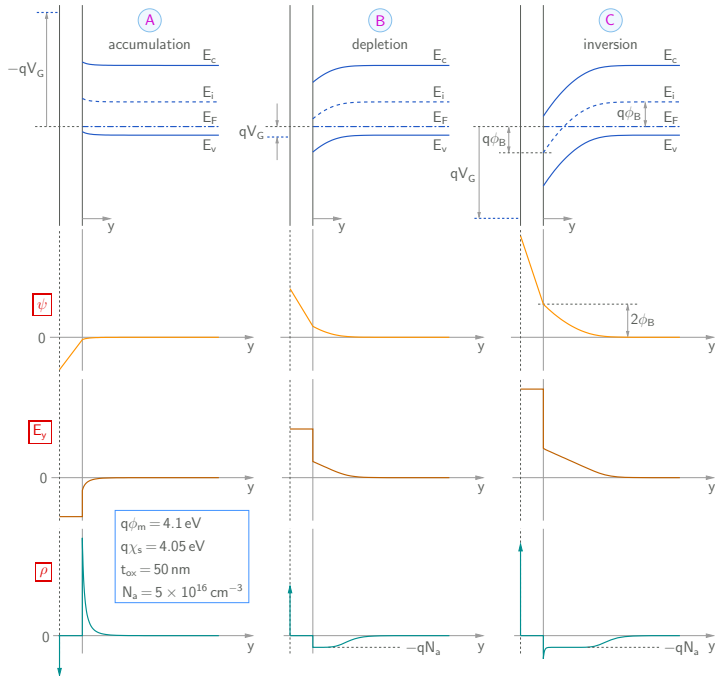
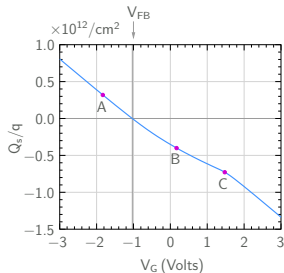


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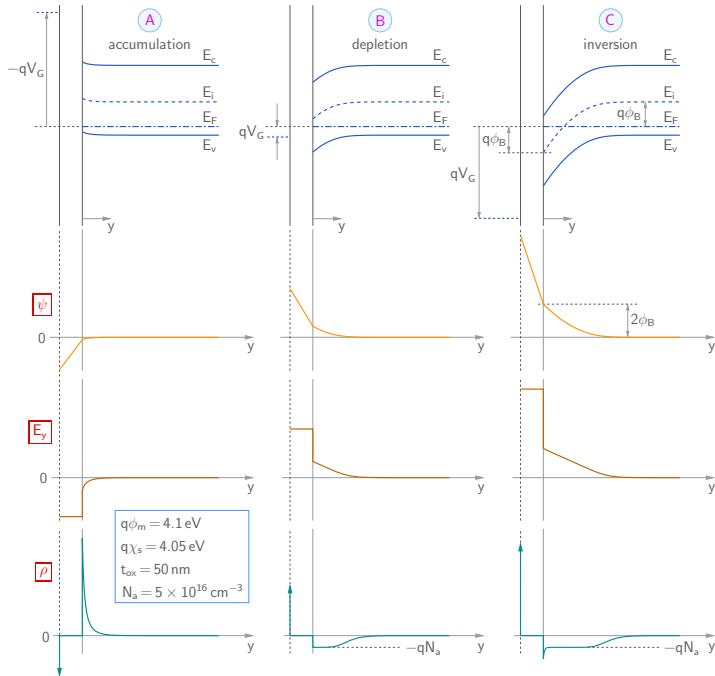
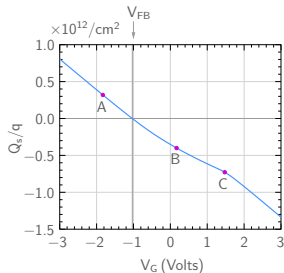


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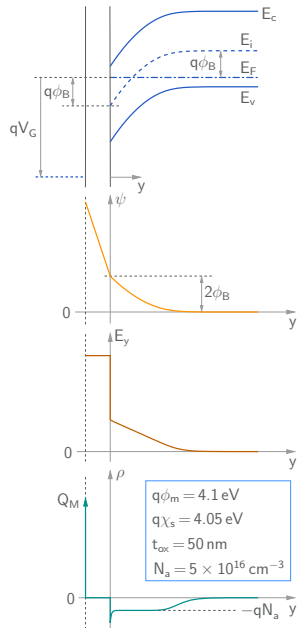
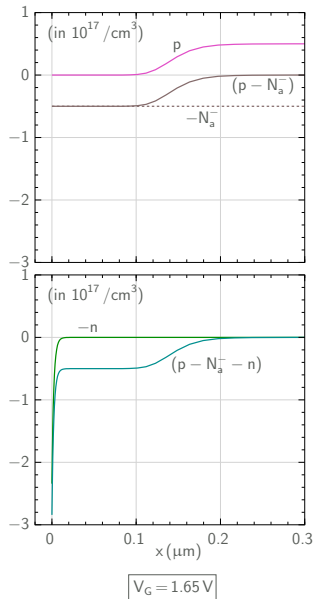
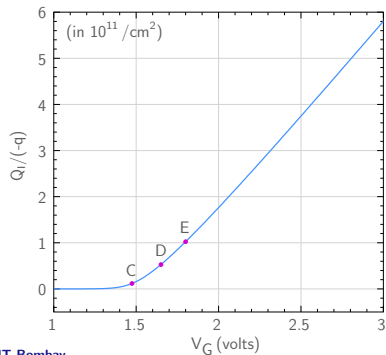
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- \*  $Q_I/(-q)$  gives the total number of electrons in the semiconductor per unit area (in the  $x$ - $z$  plane).

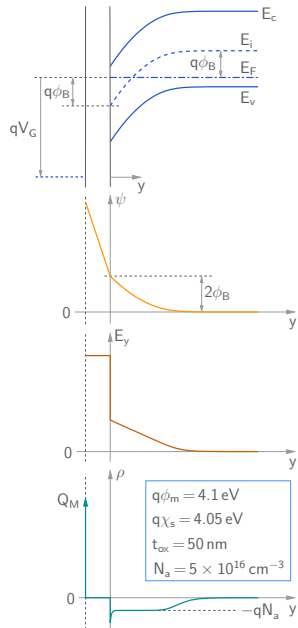
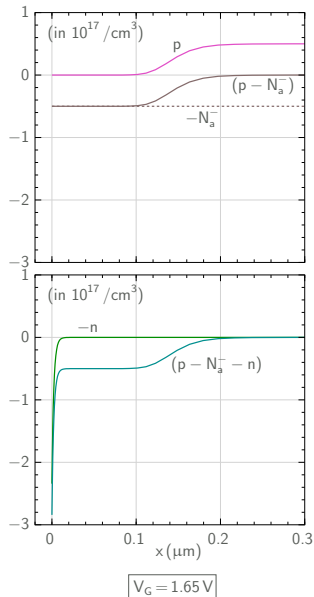
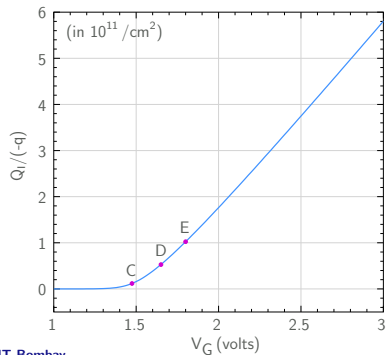


# Charge components in inversion regime:



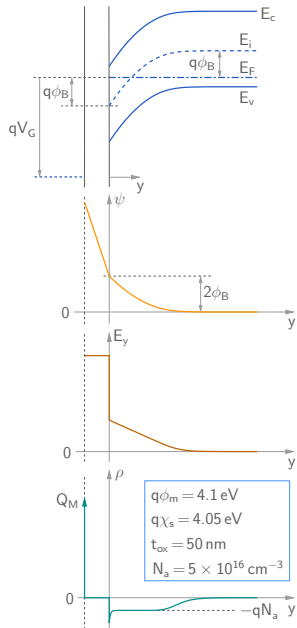
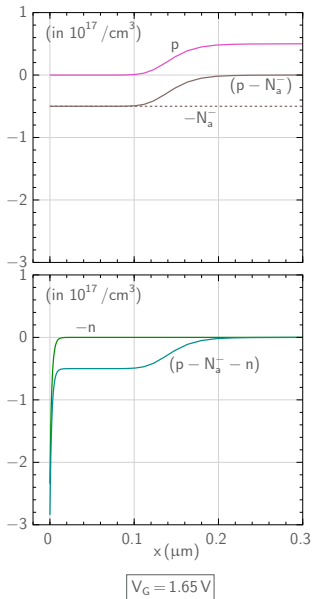
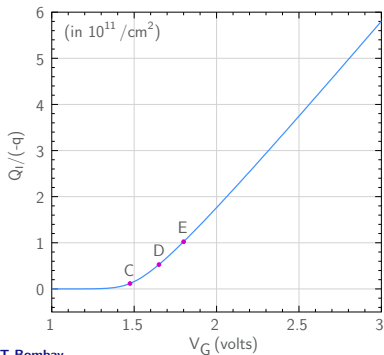
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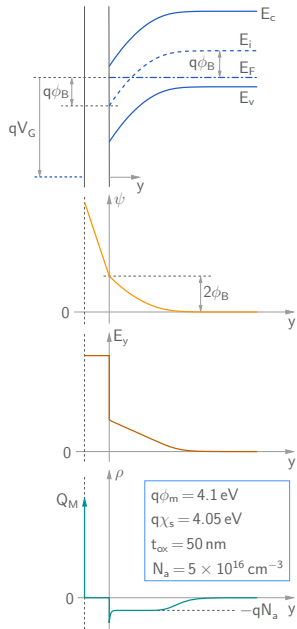
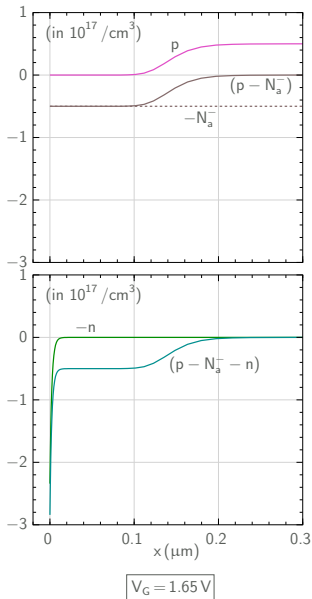
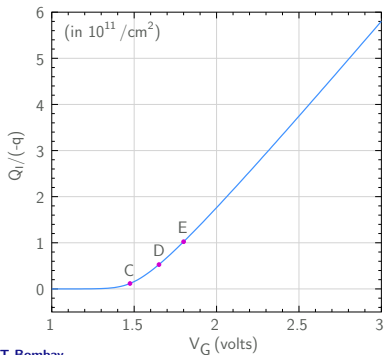
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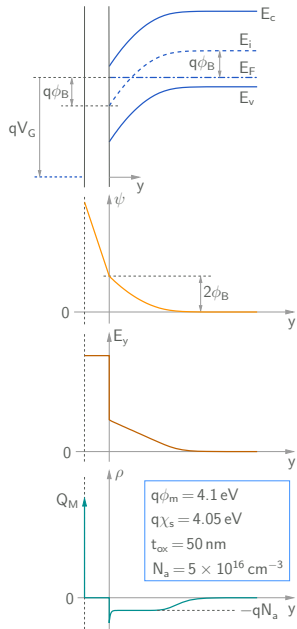
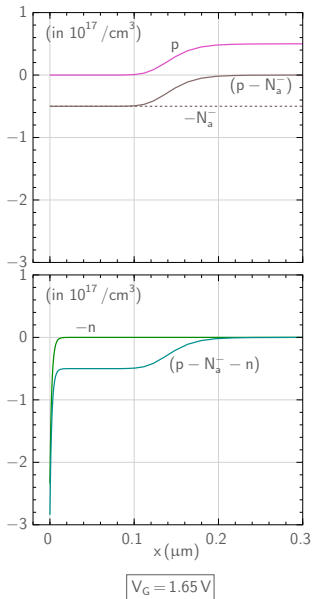
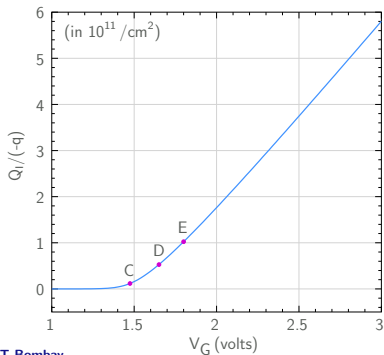
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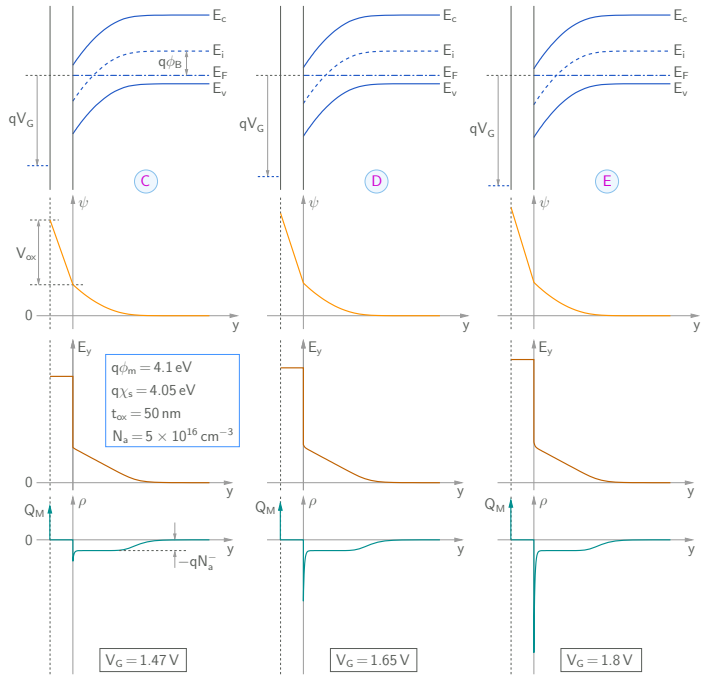
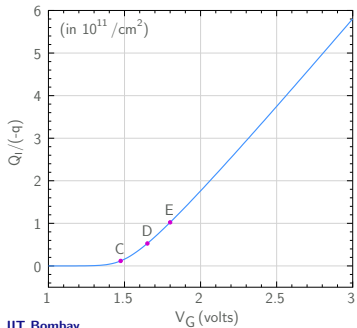


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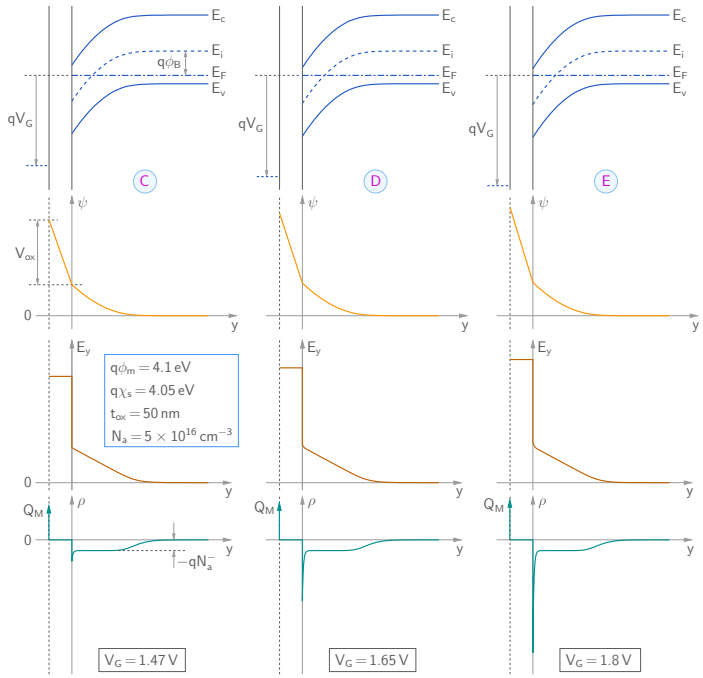
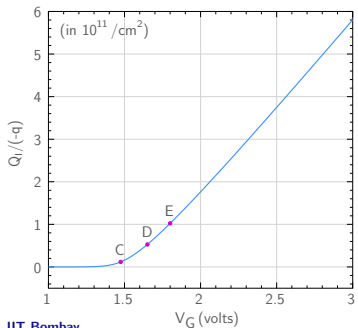
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- \*  $n(y) = n_0 = \frac{n_i^2}{p_0}$  in most of the device except near the surface where it increases dramatically.



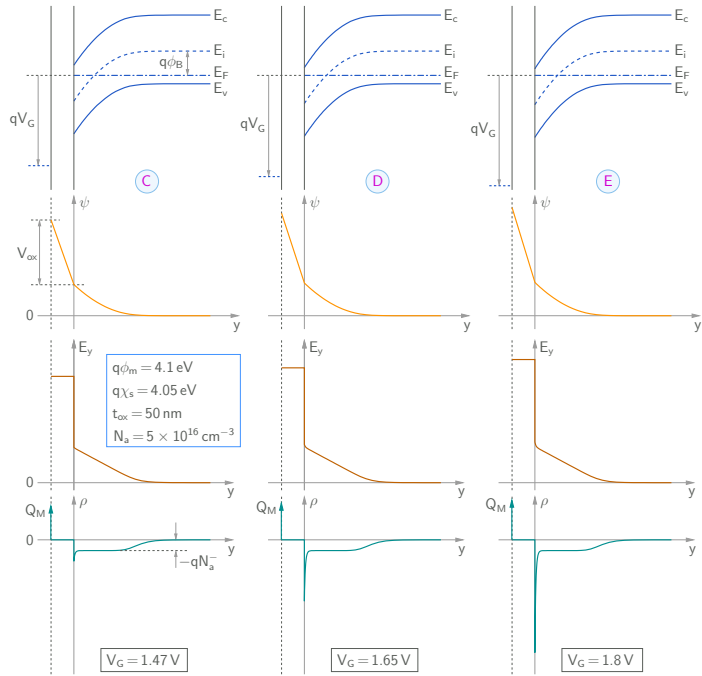
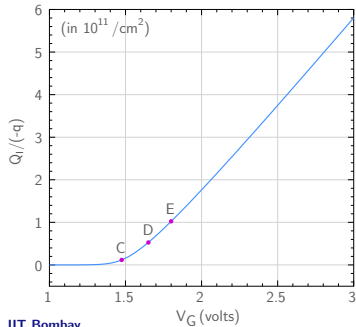




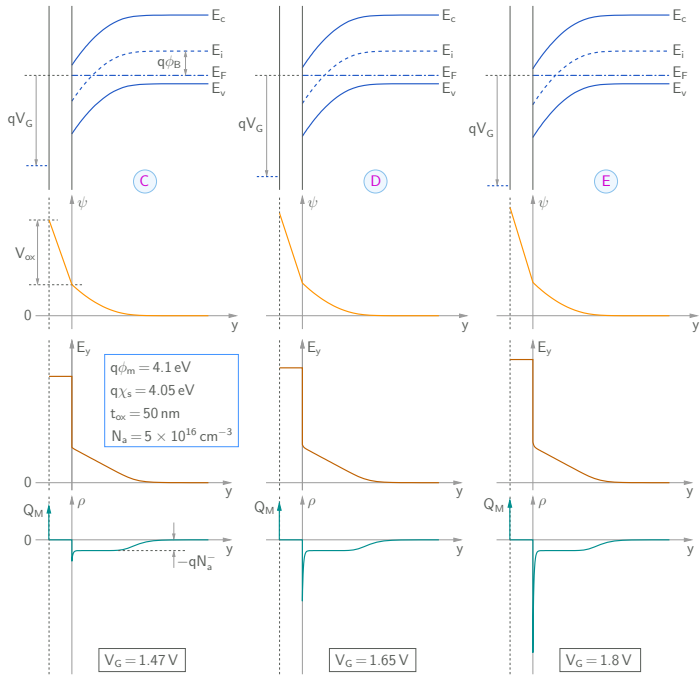
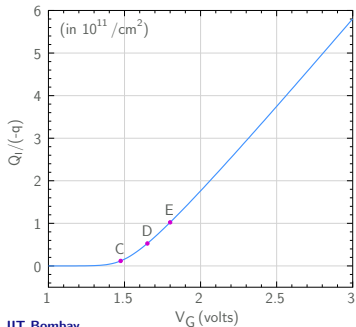
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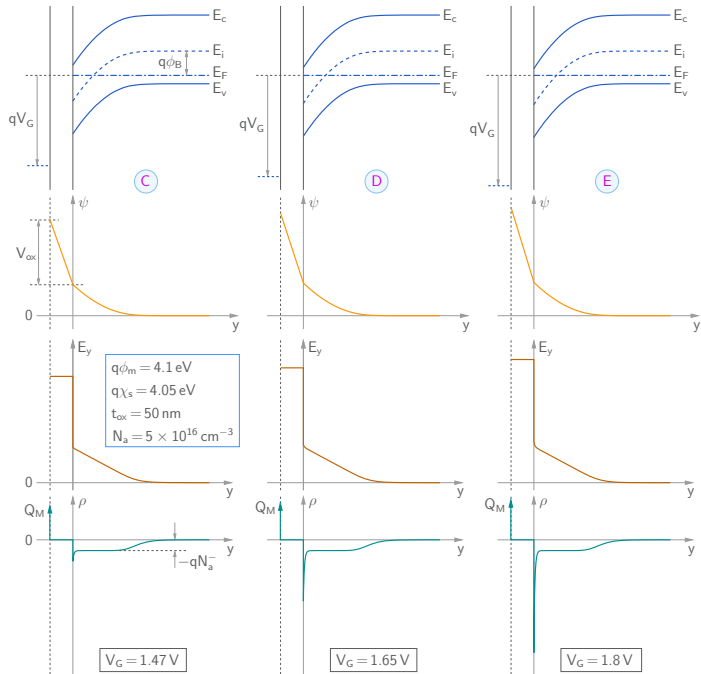
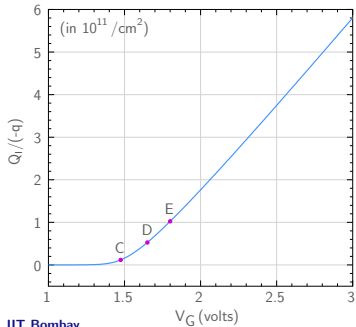
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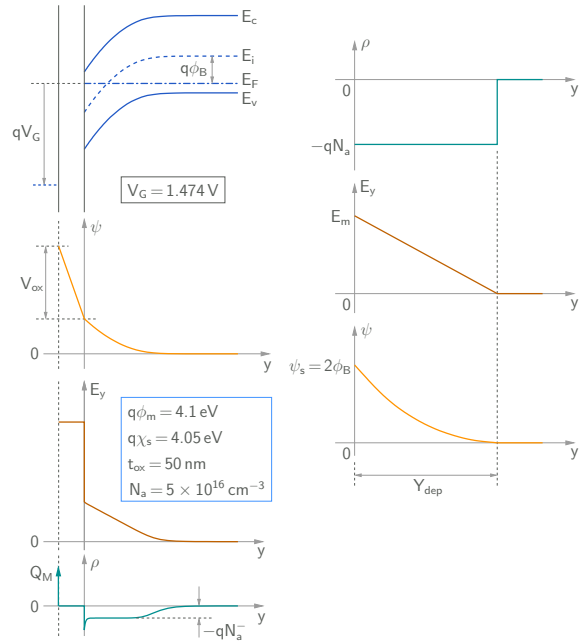
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- \* The inversion charge  $Q_i$  is confined to a narrow region near the Si-SiO<sub>2</sub> interface, typically about 10 nm (i.e., 100 Å).

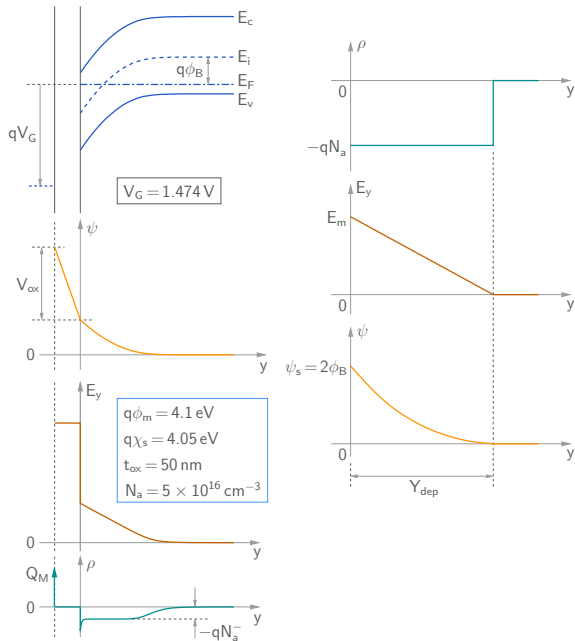


# MOS capacitor: threshold voltage



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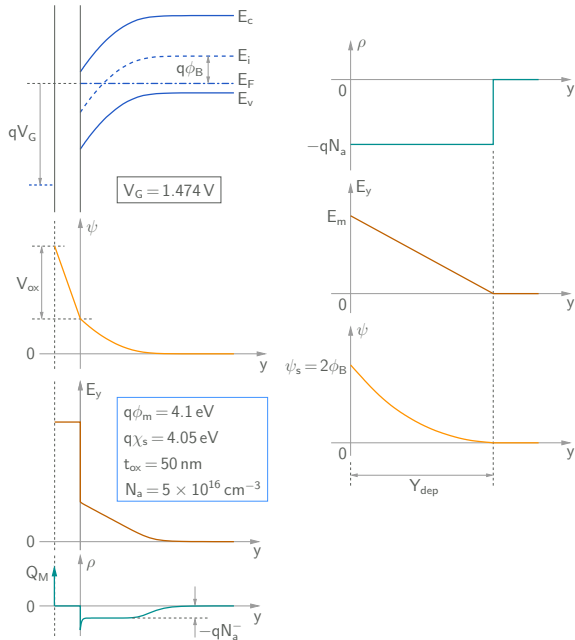


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$$\frac{d\mathcal{E}_y}{dy} = \frac{\rho}{\epsilon} \rightarrow \int_{0^+}^{Y_{\text{dep}}} d\mathcal{E}_y = \frac{1}{\epsilon_{\text{Si}}} \int_{0^+}^{Y_{\text{dep}}} \rho dy$$





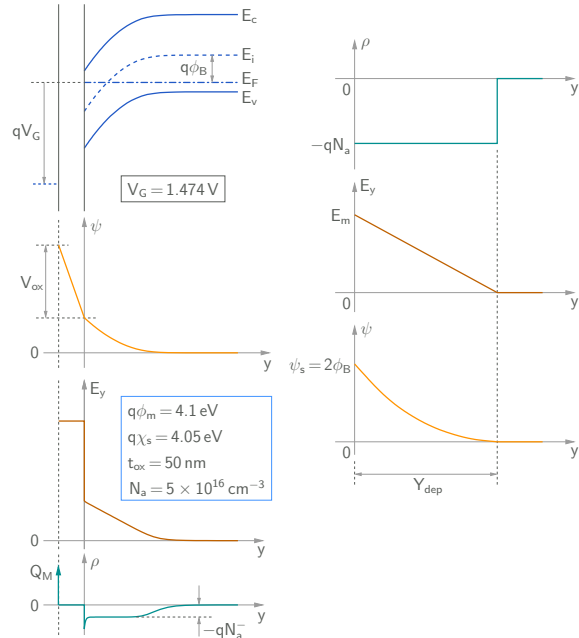
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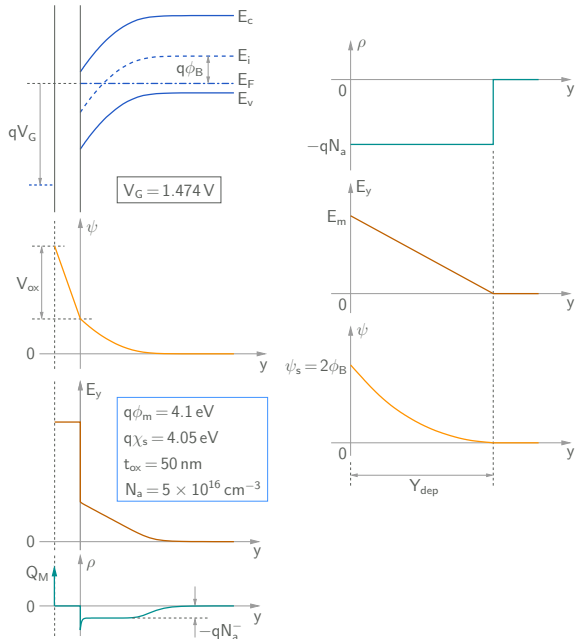
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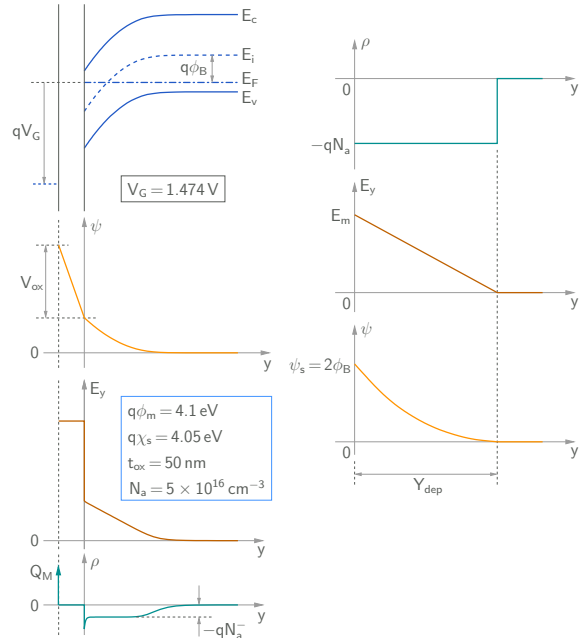
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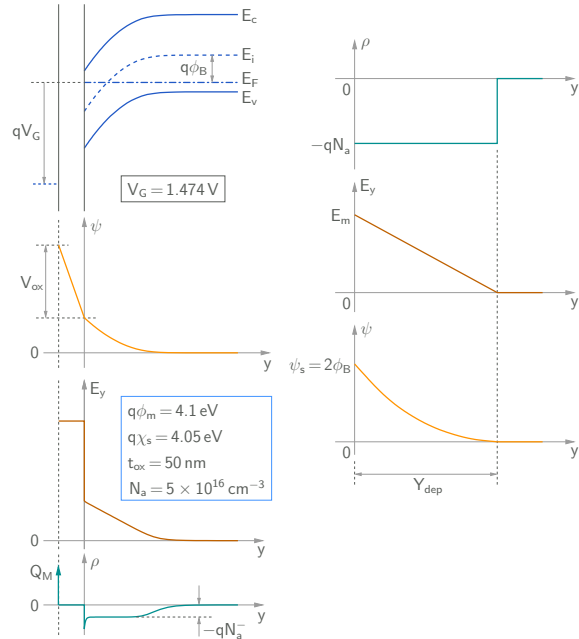
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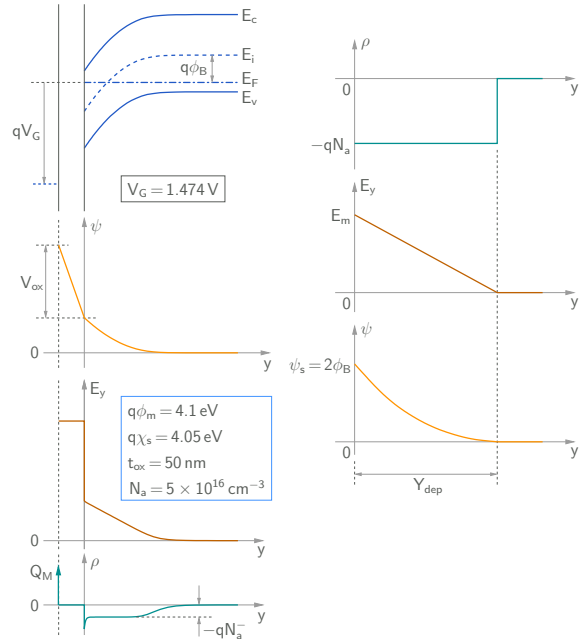
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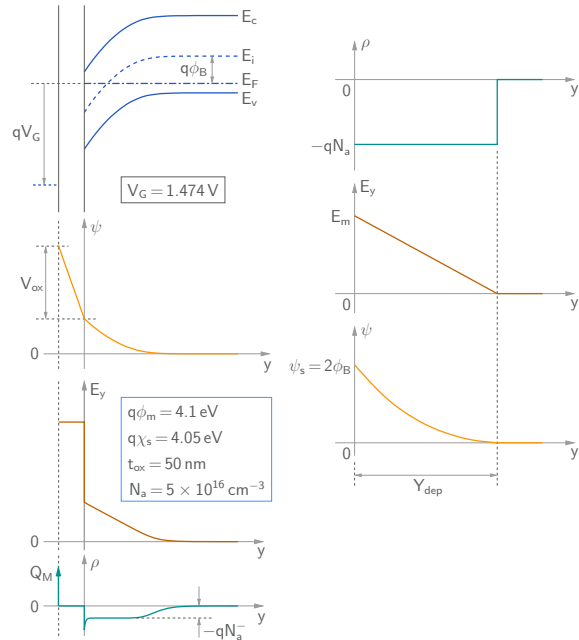
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$$\rightarrow Y_{\text{dep}} = \sqrt{\frac{4\epsilon_{\text{Si}}\phi_B}{qN_a}}.$$



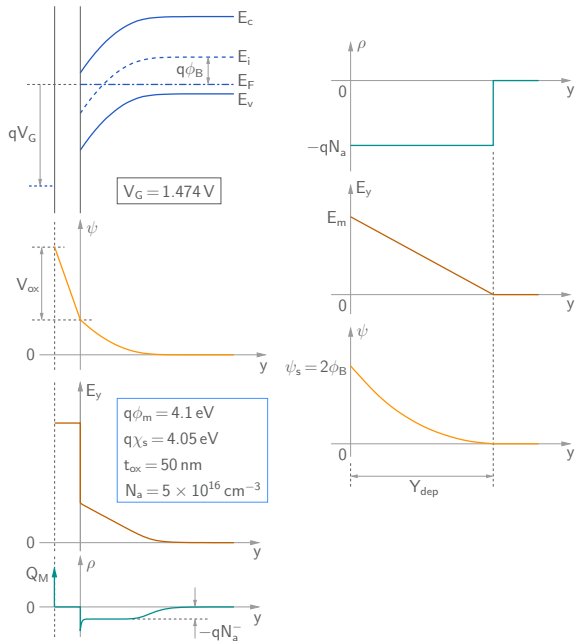
# MOS capacitor: threshold voltage



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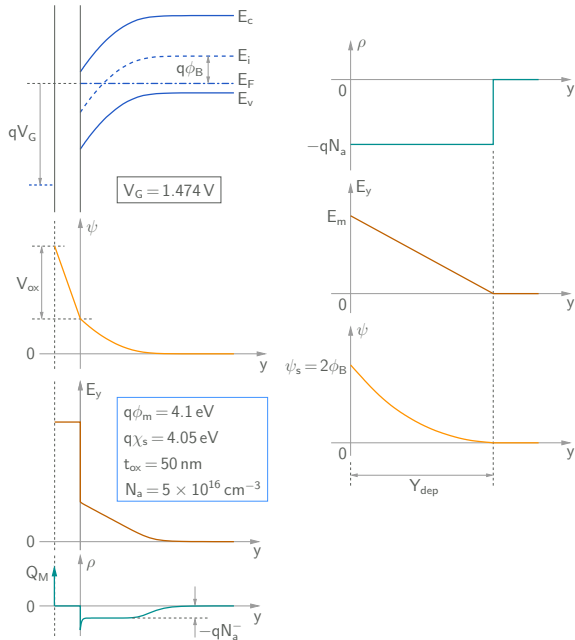


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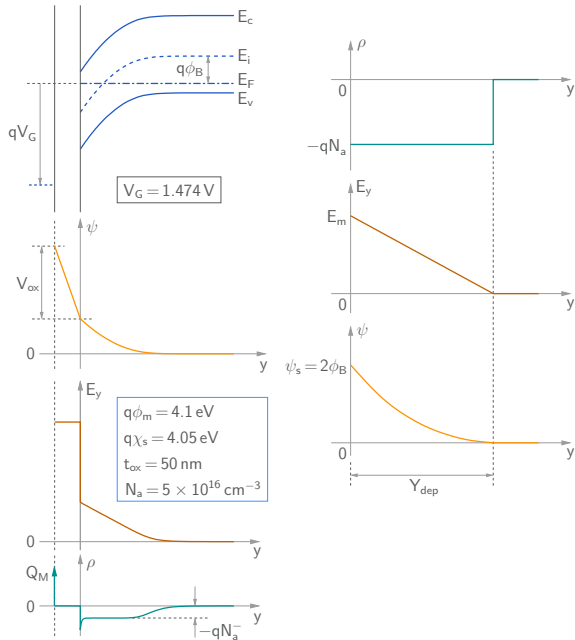




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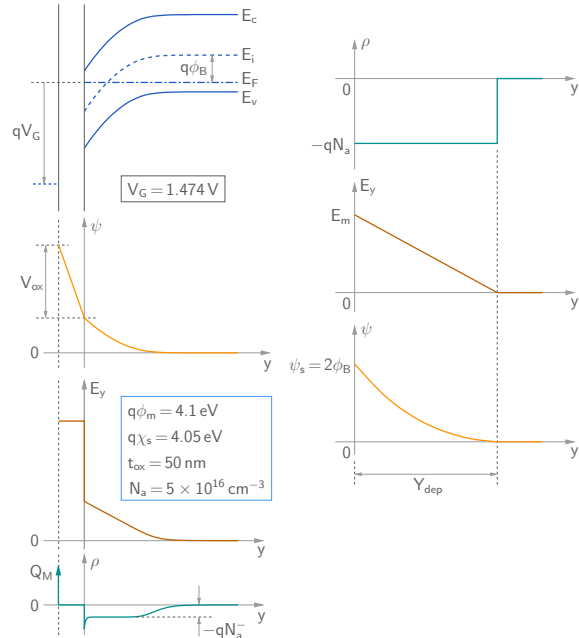


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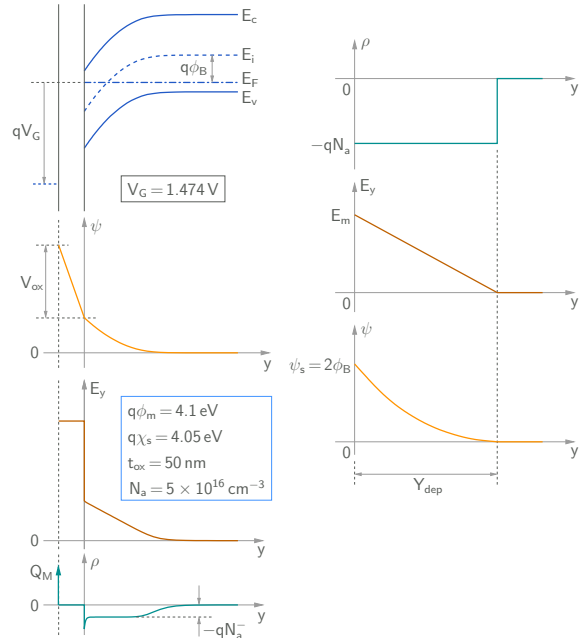


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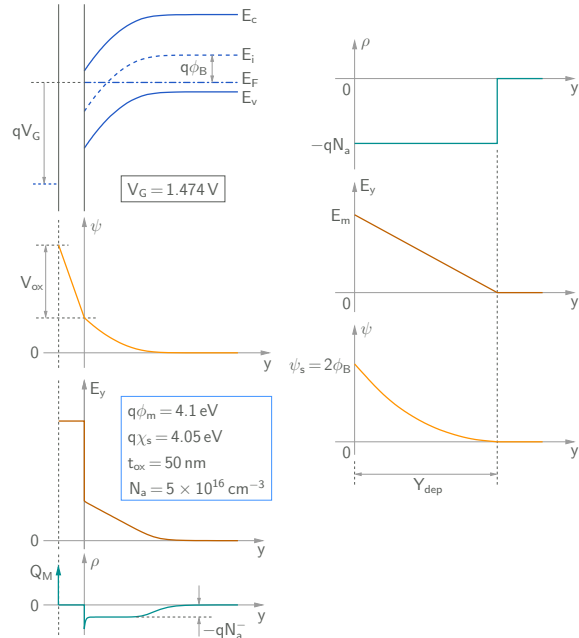
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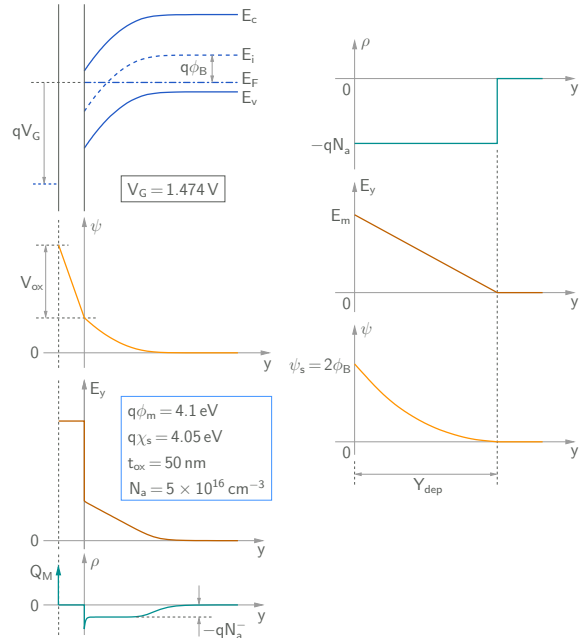
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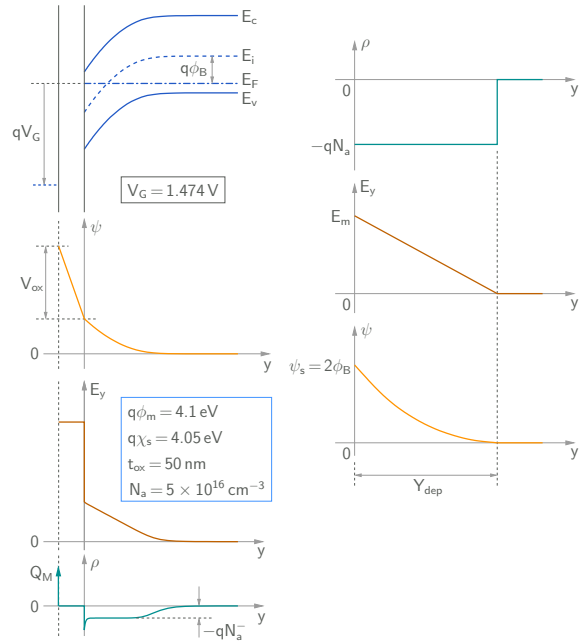
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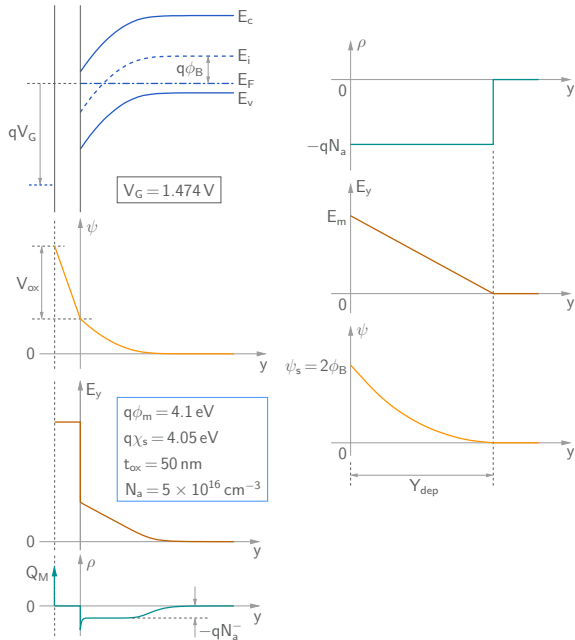


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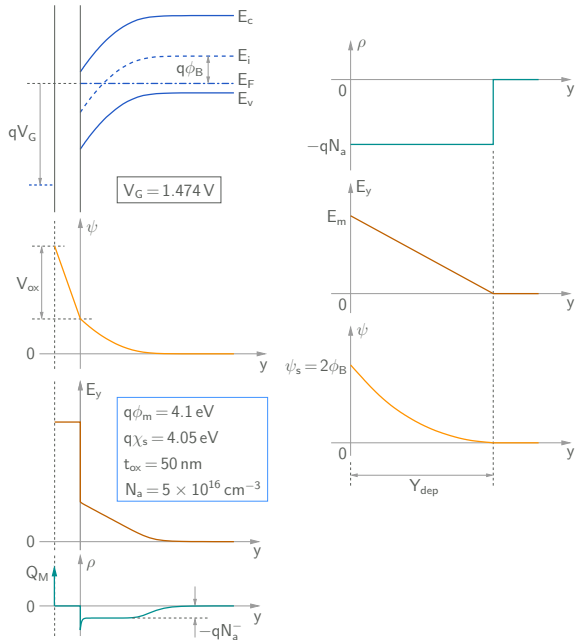
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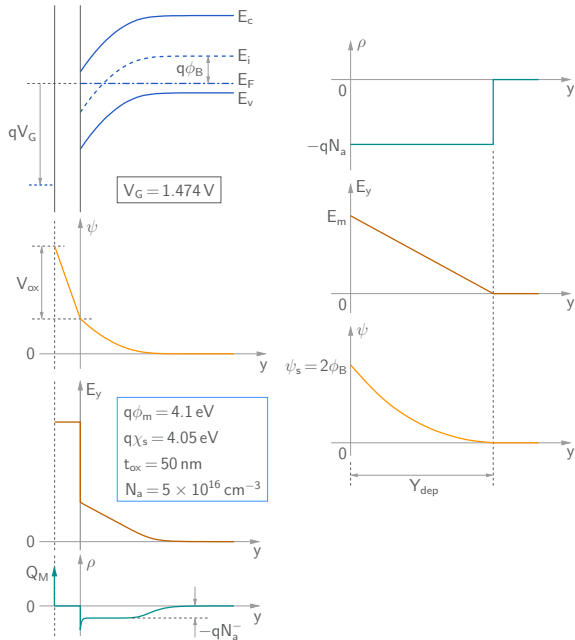


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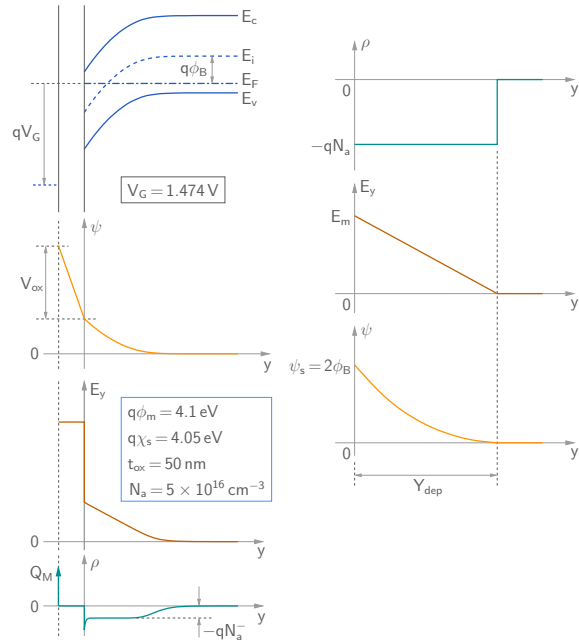
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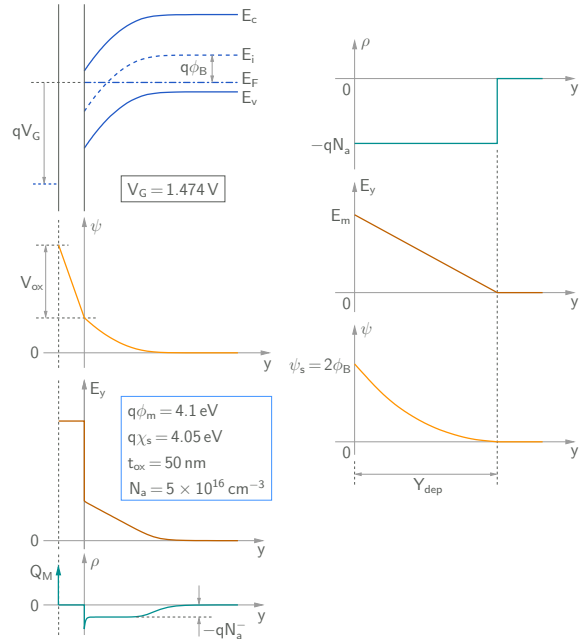
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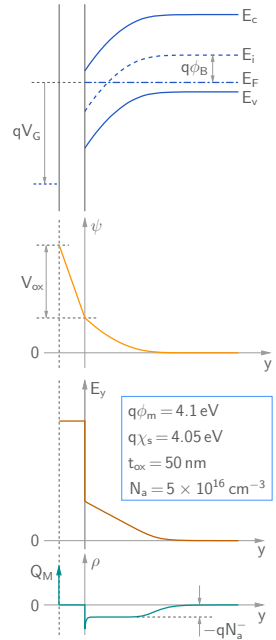
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## Example

Calculate the threshold voltage for a MOS capacitor with  $t_{\text{ox}} = 50 \text{ nm}$ ,  $\phi_m = 4.1 \text{ eV}$ ,  $\chi_s = 4.05 \text{ eV}$ ,  $N_a = 5 \times 10^{16} \text{ cm}^{-3}$ .

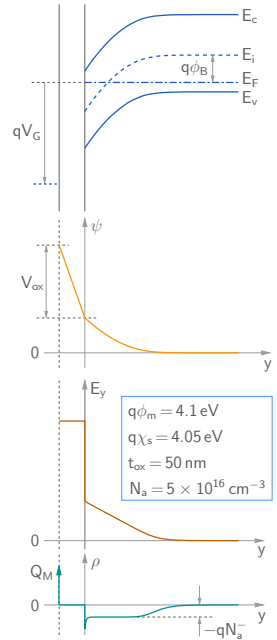


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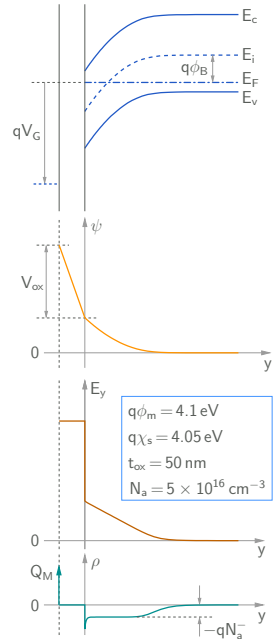
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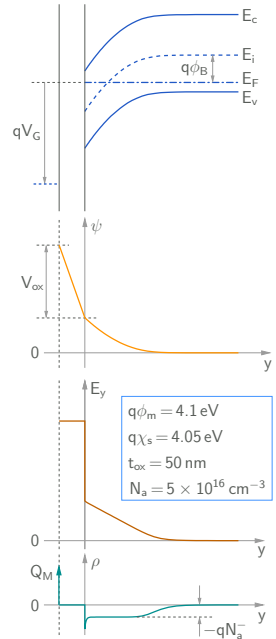
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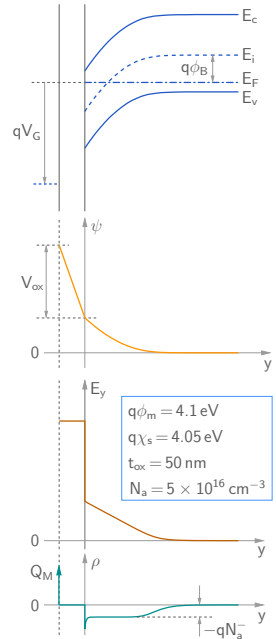
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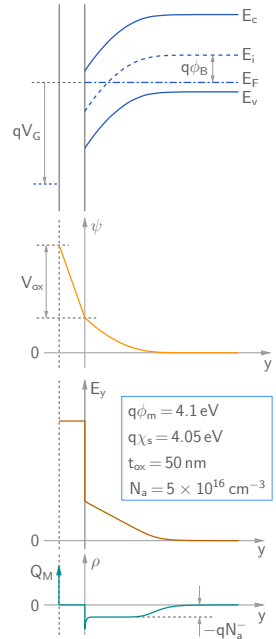
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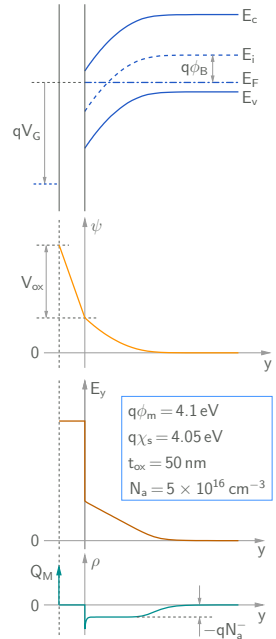
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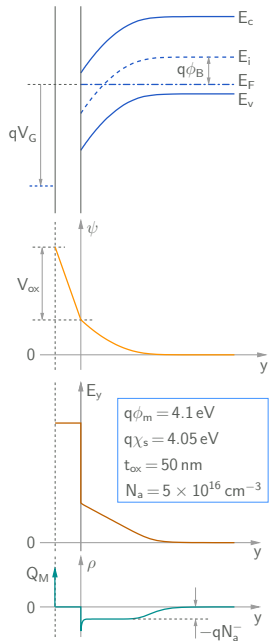
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$$\sqrt{4qN_a\epsilon_{Si}\phi_B} = \sqrt{4 \times 1.6 \times 10^{-19} \times 5 \times 10^{16} \times 11.7 \times 8.85 \times 10^{-14} \times 0.41}$$



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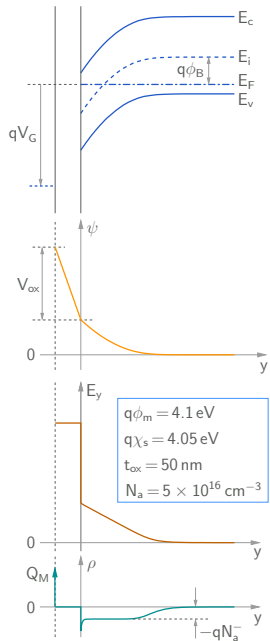
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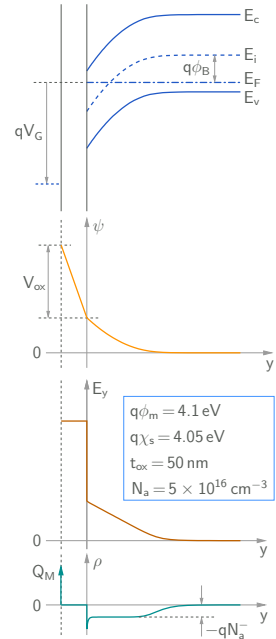
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## Example (continued)

$$V_{th} = V_{FB} + 2\phi_B + \frac{\sqrt{4qN_a\epsilon_{Si}\phi_B}}{C_{ox}}$$

$$= -0.93 + 2 \times 0.41 + \frac{1.16 \times 10^{-7}}{69 \times 10^{-9}} = 1.57 \text{ V.}$$



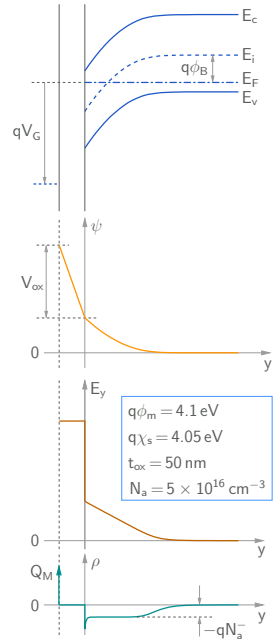
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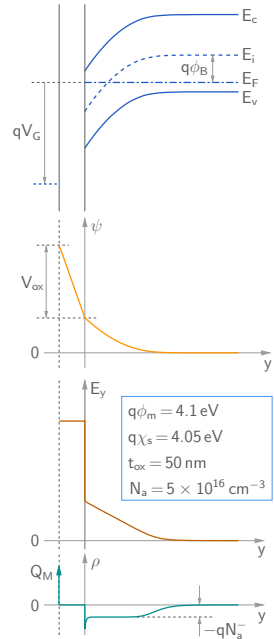
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$$= 1.45 \times 10^{-5} \text{ cm} = 0.145 \text{ } \mu\text{m}.$$



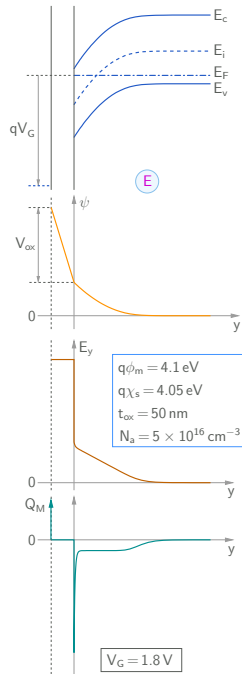
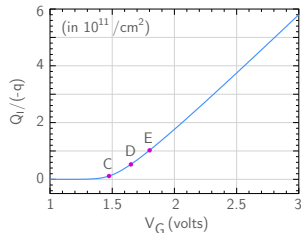
## MOS capacitor: inversion charge

Consider  $V_G > V_{th}$ . We have  $V_G = V_{FB} + \psi_s + V_{ox}$ .

The surface potential  $\psi_s$  stays approximately constant ( $= 2\phi_B$ ) in inversion.

→ The “excess” gate voltage (beyond  $V_{th}$ ) can only appear as a change in  $V_{ox}$ .

$V_G \approx V_{FB} + 2\phi_B + V_{ox}$ , where  $V_{ox} = \mathcal{E}(0^-) t_{ox} = \mathcal{E}(0^+) \frac{\epsilon_{Si}}{\epsilon_{ox}} t_{ox}$ .





MOS capacitor: inversion charge

Consider  $V_G > V_{th}$ . We have  $V_G = V_{FB} + \psi_s + V_{ox}$ .

The surface potential  $\psi_s$  stays approximately constant ( $=2\phi_B$ ) in inversion.

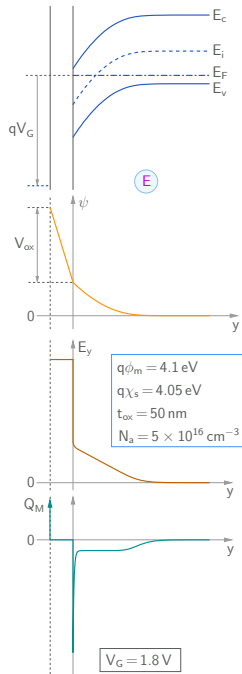
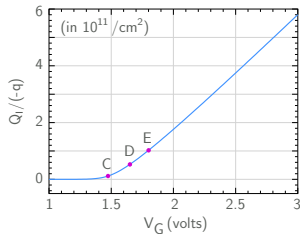
→ The “excess” gate voltage (beyond  $V_{th}$ ) can only appear as a change in  $V_{ox}$ .

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$$\int_{0^+}^{Y_{\text{dep}}} d\mathcal{E}_y = \frac{1}{\epsilon_{\text{Si}}} \int_{0^+}^{Y_{\text{dep}}} \rho dy = \frac{1}{\epsilon_{\text{Si}}} \int_{0^+}^{Y_{\text{dep}}} q(-N_a^- - n) dy$$

$$\rightarrow \mathcal{E}(Y_{\text{dep}}) - \mathcal{E}(0^+) = -\mathcal{E}(0^+) = \frac{1}{\epsilon_{\text{Si}}} (-qN_a Y_{\text{dep}} + Q_I) \rightarrow \mathcal{E}(0^+) = \frac{qN_a Y_{\text{dep}}}{\epsilon_{\text{Si}}} - \frac{Q_I}{\epsilon_{\text{Si}}}, \text{ where}$$

$$Y_{\text{dep}} \approx Y_{\text{dep}}^{\text{inv}} = \sqrt{\frac{4\epsilon_{\text{Si}}\phi_B}{qN_a}} \quad (= \text{depletion width at the onset of inversion}).$$



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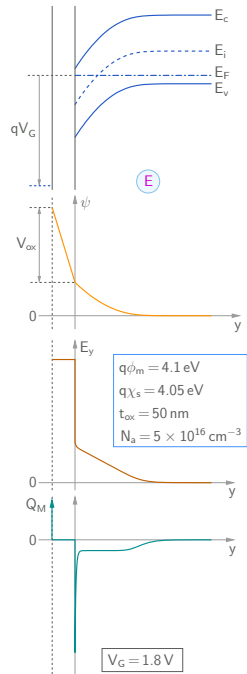
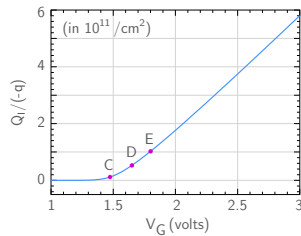
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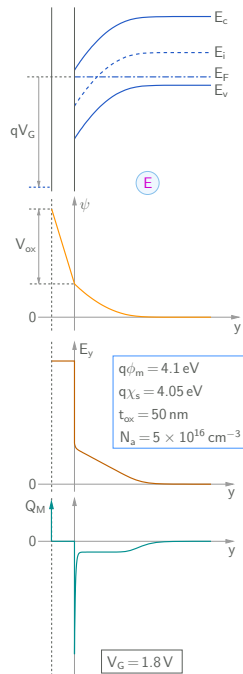
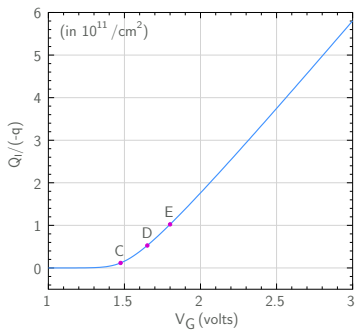
Putting together the various terms, we get

$$V_G = V_{FB} + 2\phi_B + \frac{\sqrt{4qN_a\epsilon_{Si}\phi_B}}{C_{ox}} - \frac{Q_I}{C_{ox}} = V_{th} - \frac{Q_I}{C_{ox}}.$$

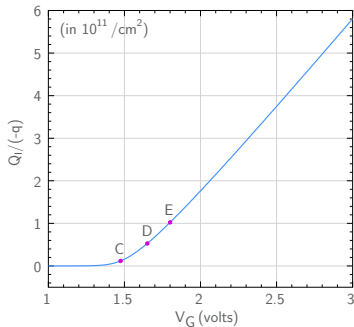
$$\rightarrow Q_I = -C_{ox}(V_G - V_{th}).$$



# MOS capacitor: inversion charge



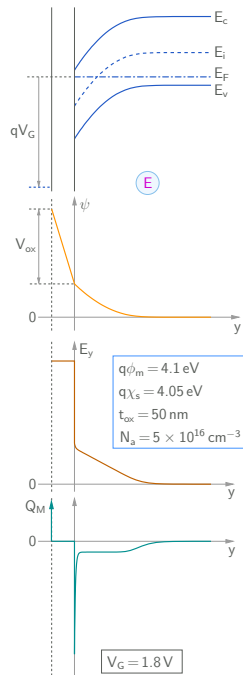
## MOS capacitor: inversion charge



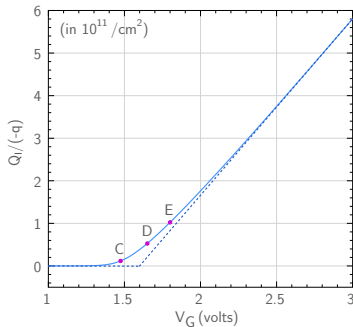
In a MOS capacitor with a uniformly doped *p*-type substrate, we can describe the inversion charge with the following approximate relationship.

$$Q_I = 0, \quad V_G \leq V_{th},$$

$$= -C_{ox}(V_G - V_{th}), \quad V_G > V_{th}.$$



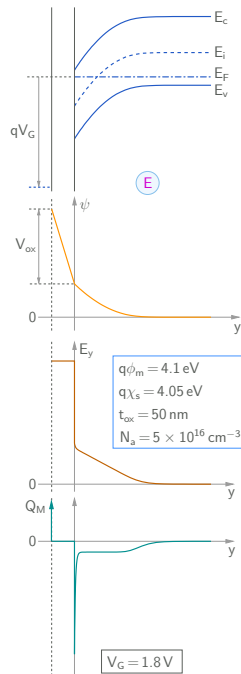
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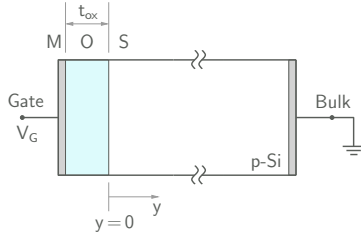
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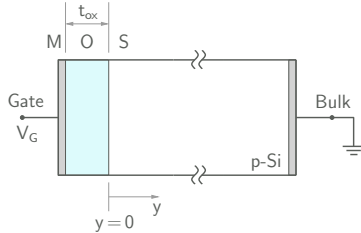
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## MOS capacitor: $C$ - $V$ relationship

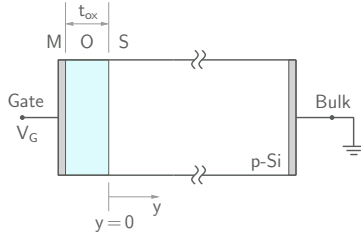


## MOS capacitor: $C$ - $V$ relationship



- \* The DC current through the MOS structure is zero because of the insulator, and it behaves like a capacitor.

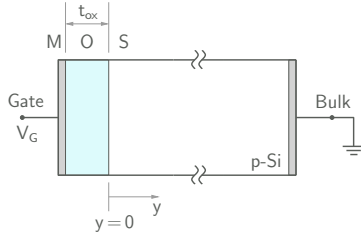
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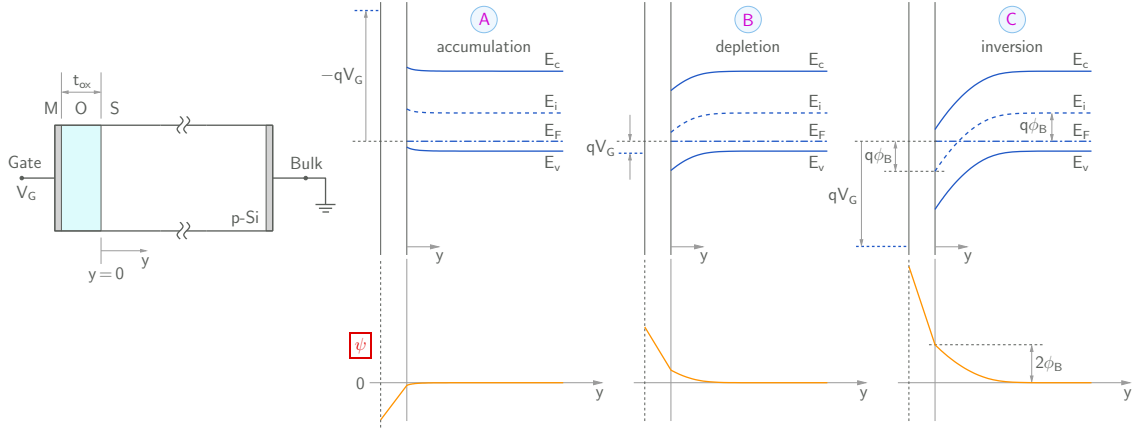


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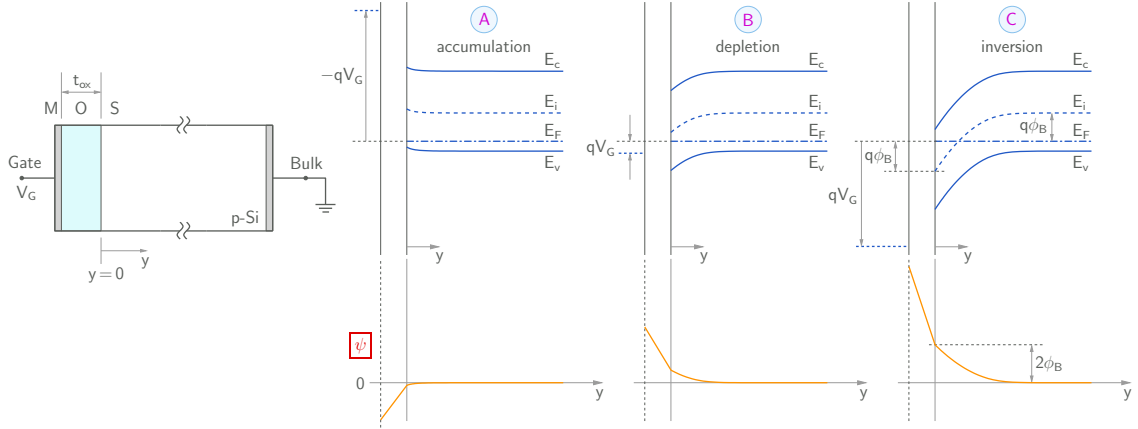


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- \* The differential capacitance  $C = \frac{dQ}{dV_G}$  is of great interest since it contains information about several important parameters, such as the oxide thickness, oxide charge, and doping density in the semiconductor.
- \*  $C$  depends on the bias (DC) value of  $V_G$ . A plot of the capacitance  $C$  versus the bias voltage is known as the MOS  $C$ - $V$  curve, and it serves as an important tool for process evaluation.

# MOS capacitor: $C$ - $V$ relationship

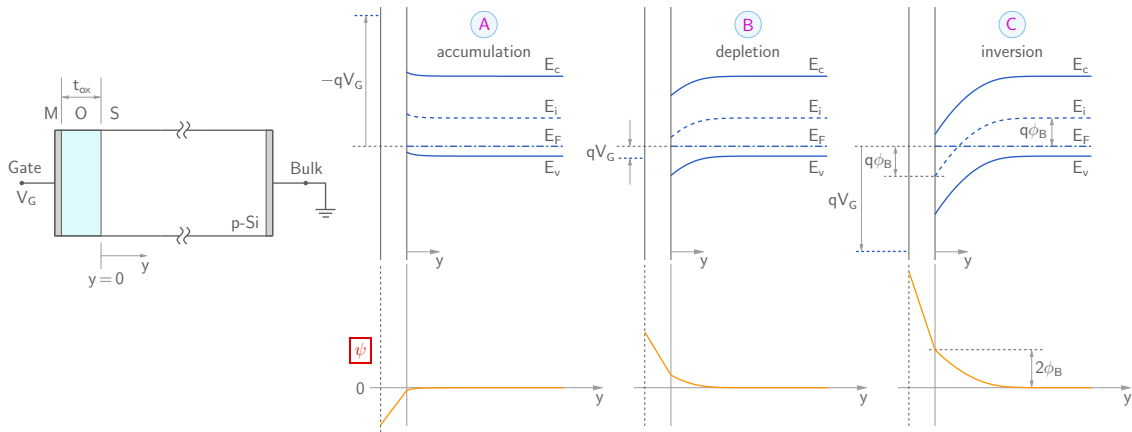


# MOS capacitor: $C$ - $V$ relationship



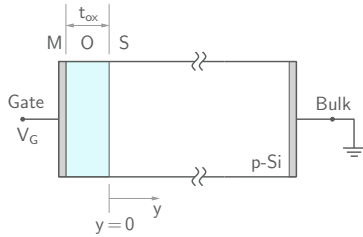
\*  $V_G = V_{FB} + V_{ox} + \psi_{Si}$ .

# MOS capacitor: C-V relationship

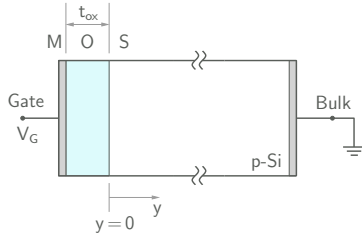


- \*  $V_G = V_{FB} + V_{ox} + \psi_{Si}$ .
- \*  $\psi_{Si}$ , the voltage drop across the semiconductor, is the same as the surface potential  $\psi_s$  if we take  $\psi(\infty)$  as 0 V.

## MOS capacitor: $C$ - $V$ relationship

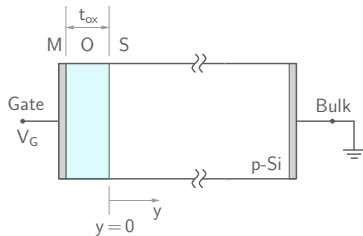


## MOS capacitor: $C$ - $V$ relationship



Let  $Q$  be the charge per unit area on the metal:  $Q = -Q_s = -\int_0^\infty \rho dy$ .

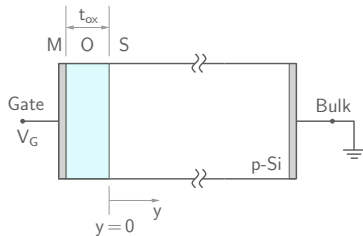
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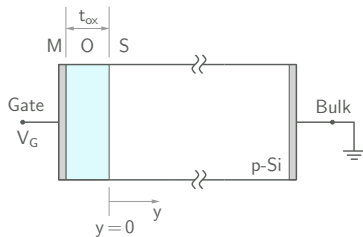
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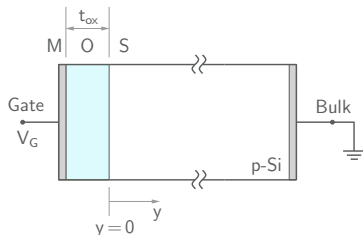


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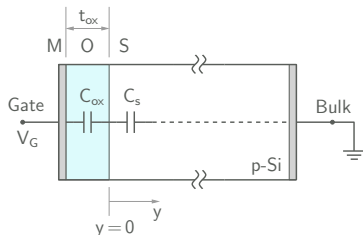
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i.e.,  $C = \frac{dQ}{dV_G}$  is given by  $\frac{1}{C} = \frac{1}{C_{ox}} + \frac{1}{C_s}$ , a series connection of  $C_{ox}$  and  $C_s$ .

## MOS capacitor: C-V relationship

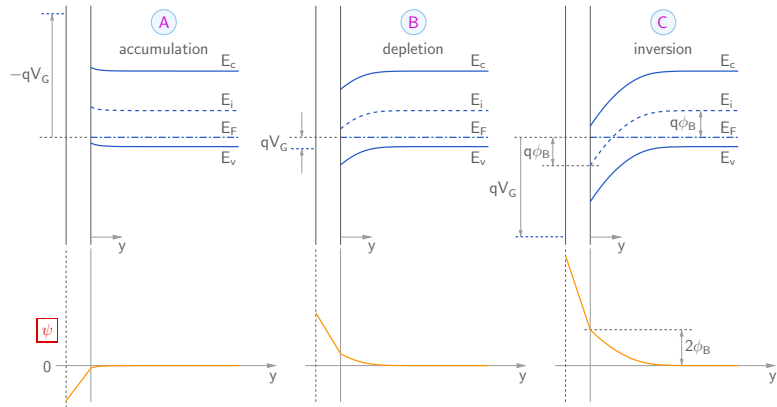


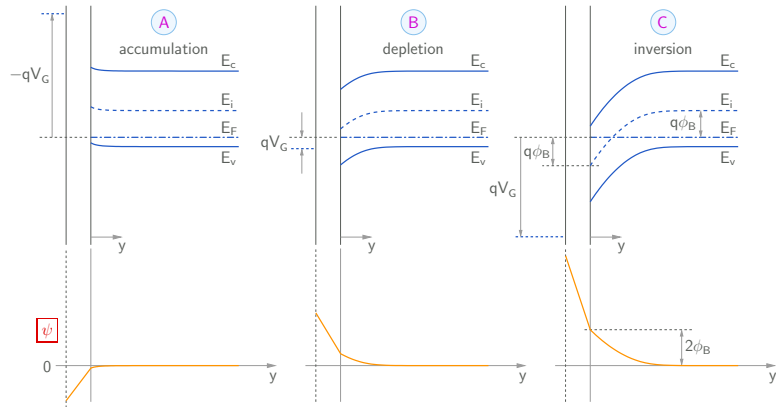
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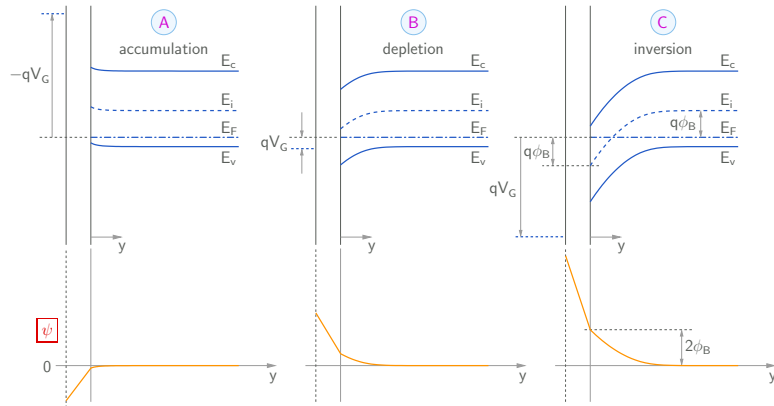
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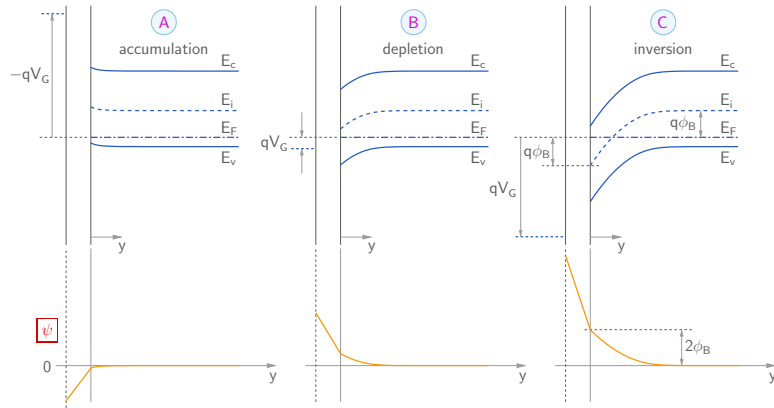




To obtain  $Q_s(\psi_s)$ , we start with  $n = n_0 e^{\psi/V_T}$ ,  $p = p_0 e^{-\psi/V_T}$ ,  $N_a^- \approx N_a = p_0 - n_0$ .



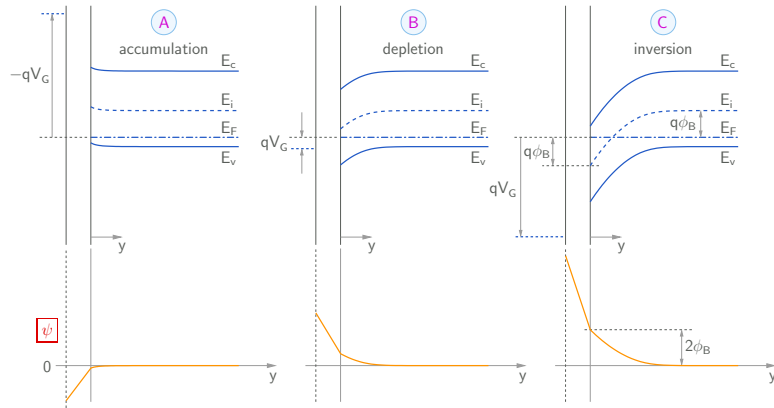
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Sufficiently far from the interface,  $\psi = 0$  V,  $n = n_0$ ,  $p = p_0$ ,  $\rho = p - n - N_a^- = 0$ .



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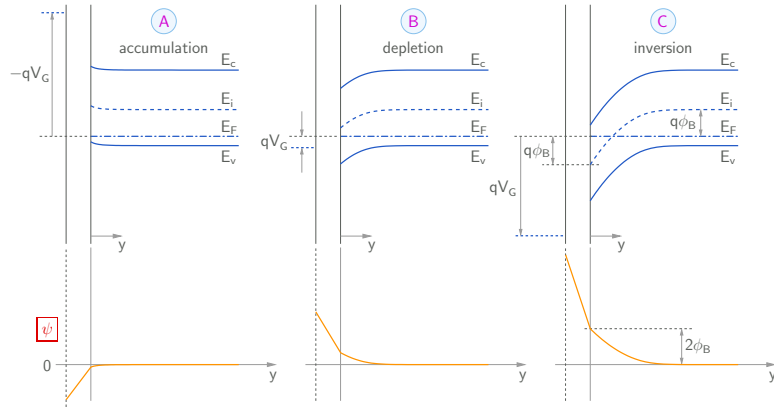
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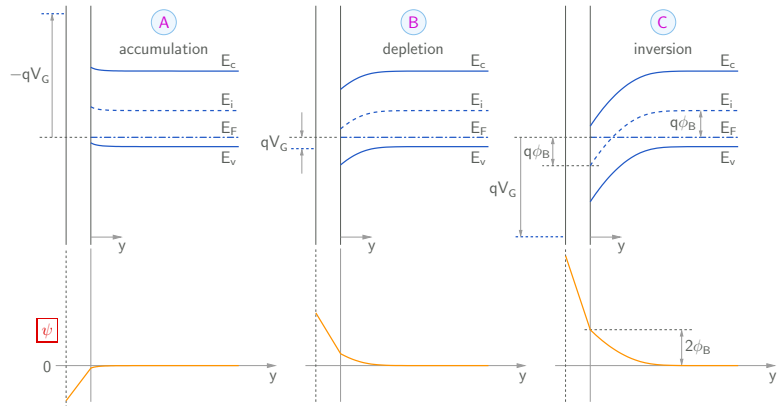


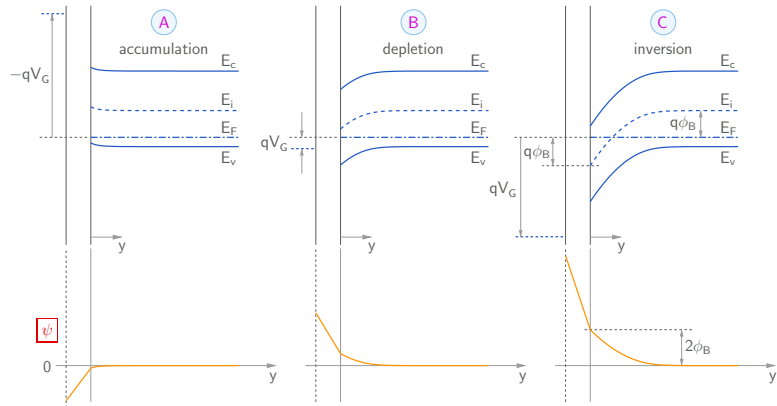
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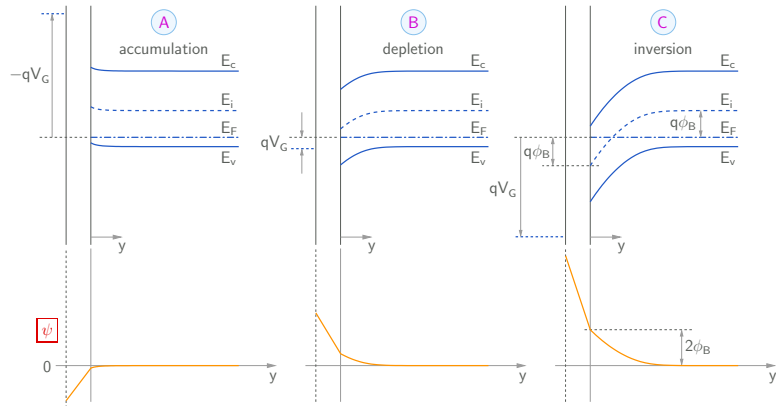
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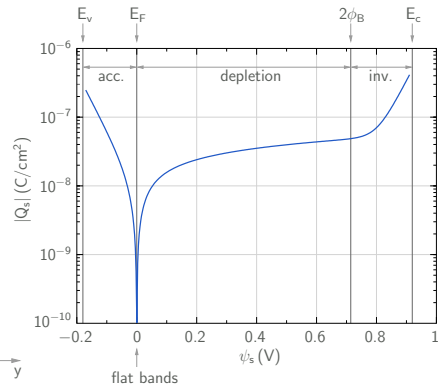
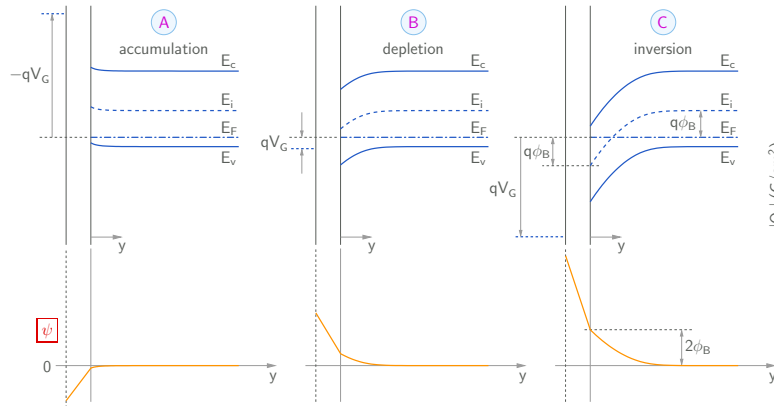


$$\int_{y=0^+}^{\infty} \mathcal{E} d\mathcal{E} = \frac{q}{\epsilon_{Si}} \int_{\psi_s}^0 \left[ n_0 \left( e^{\psi/V_T} - 1 \right) - p_0 \left( e^{-\psi/V_T} - 1 \right) \right] d\psi.$$



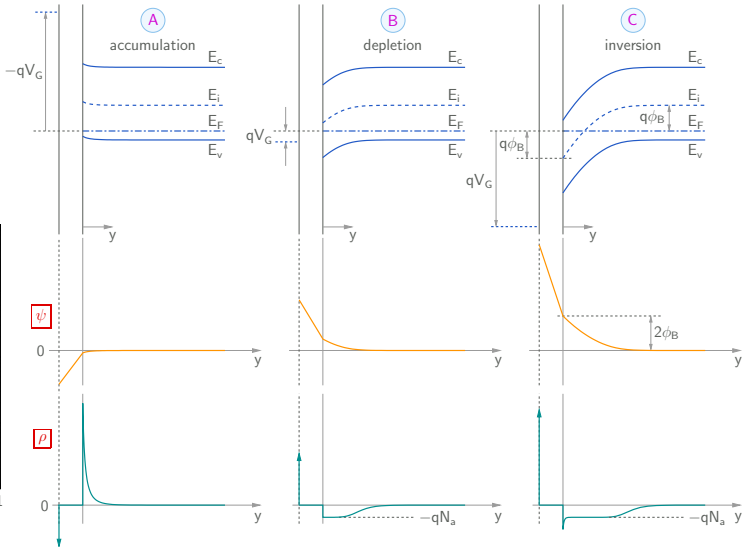
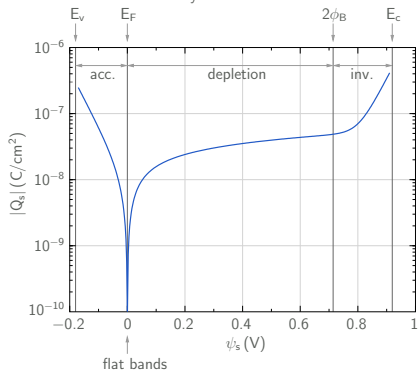
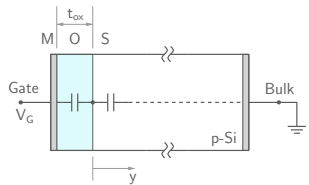
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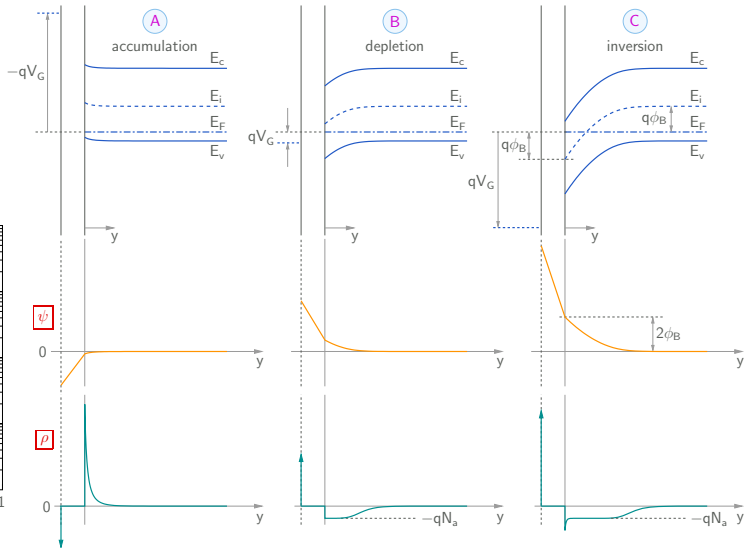
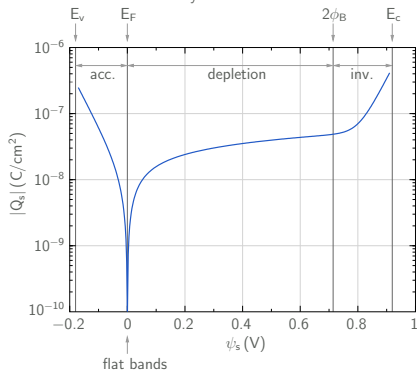
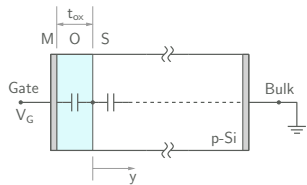
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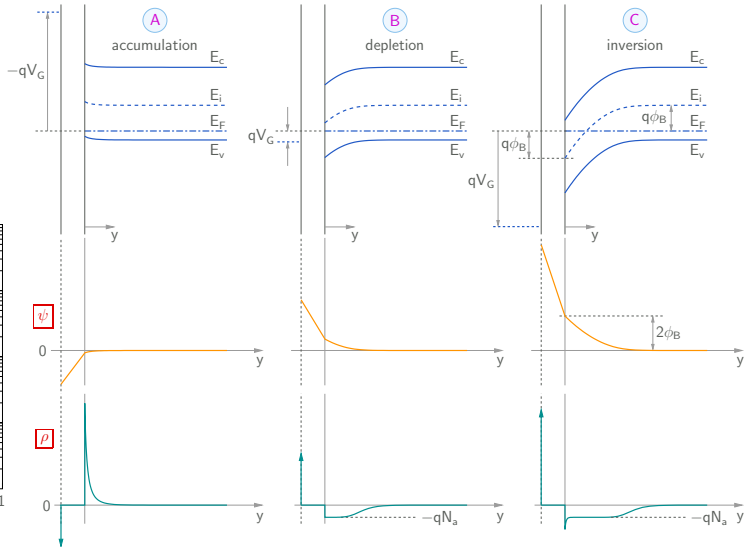
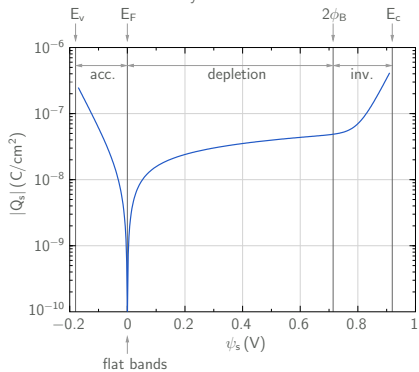
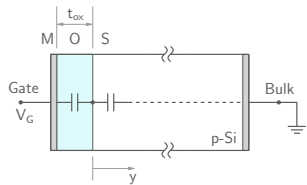
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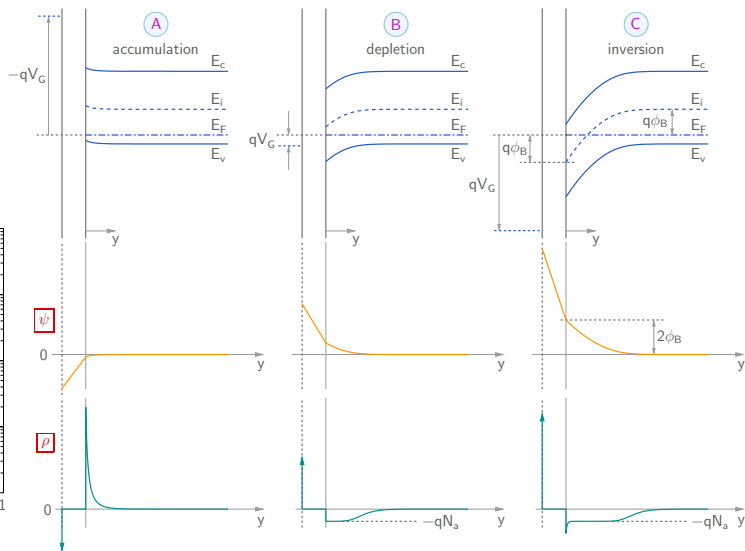
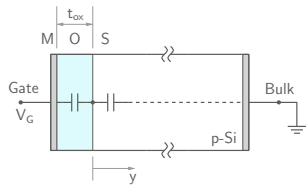




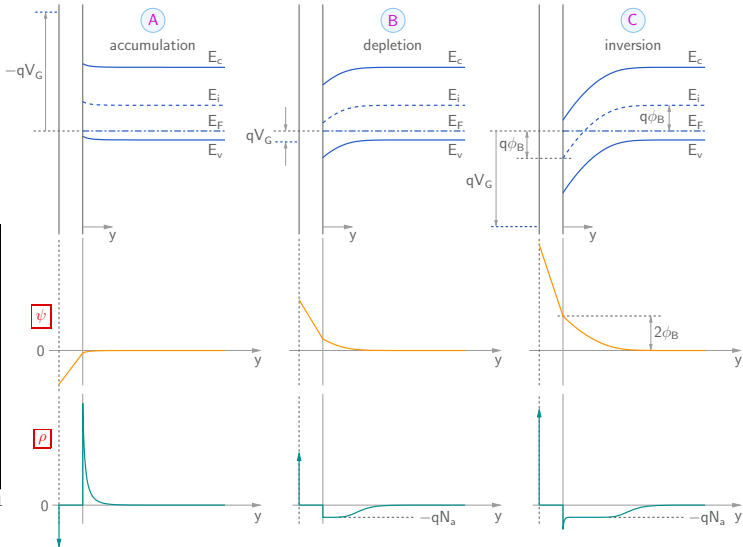
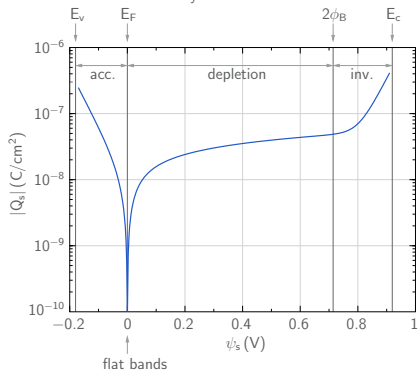
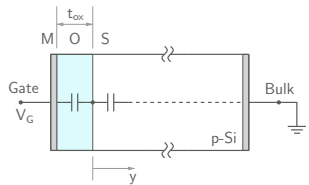
\* In accumulation ( $\psi_s < 0$  V) and inversion ( $\psi_s > 2\phi_B$ ),  $Q_s$  changes rapidly with  $\psi_s$  because  $p \propto e^{-(E_F - E_v)/kT}$ ,  $n \propto e^{-(E_c - E_F)/kT}$ .

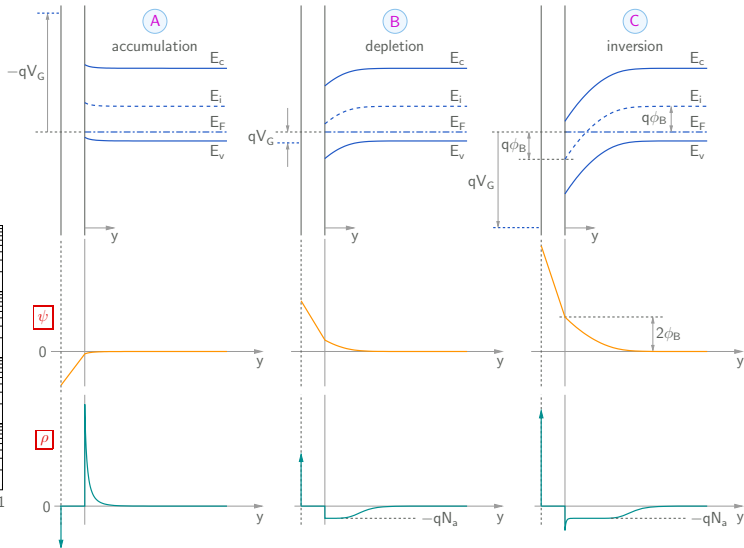
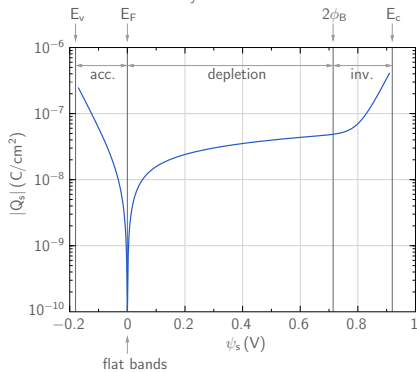
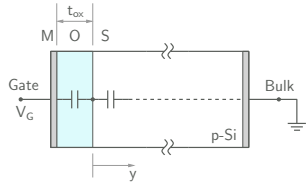




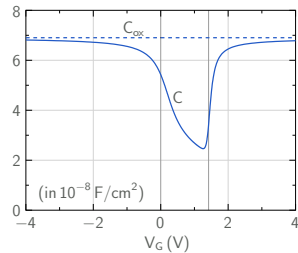
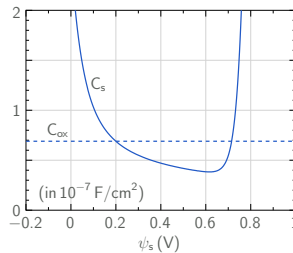
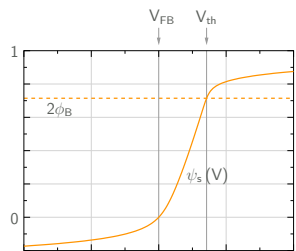
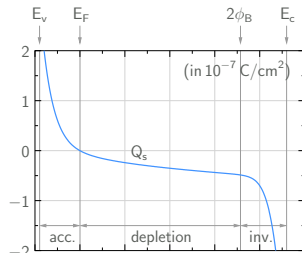
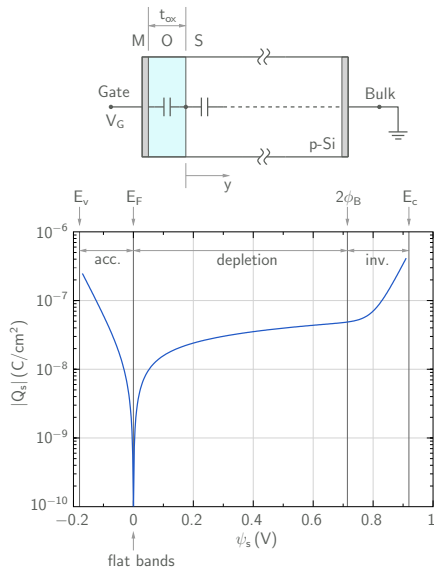


\* In the depletion regime, the region near the surface is depleted of electrons and holes, and the variation of  $Q_s$  with  $\psi_s$  comes from the change in the ionised acceptor charge, i.e., the change in the depletion width with  $\psi_s$ .

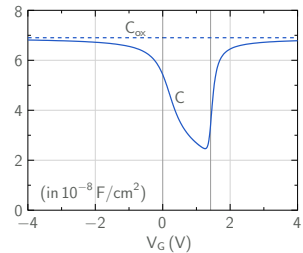
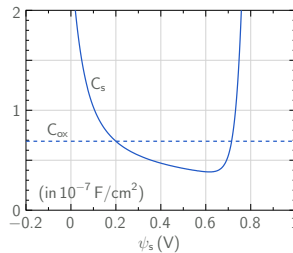
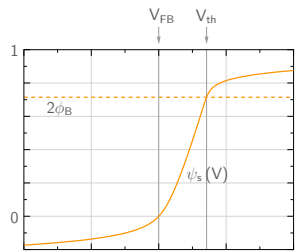
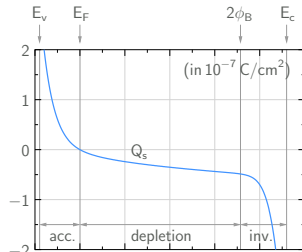
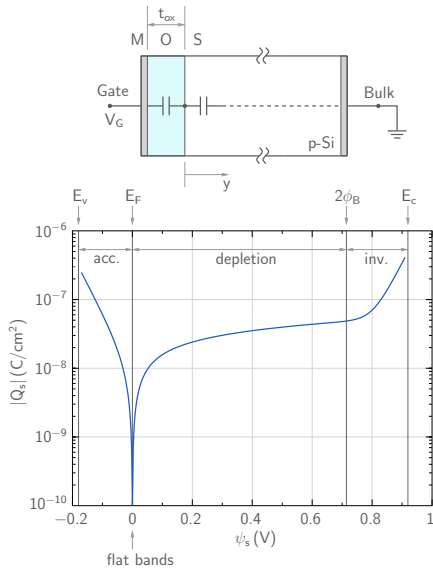




\* Since the depletion width varies relatively slowly with  $\psi_s$  (as  $\sqrt{\psi_s}$ ),  $\frac{dQ}{d\psi_s}$  is relatively small in the depletion regime.

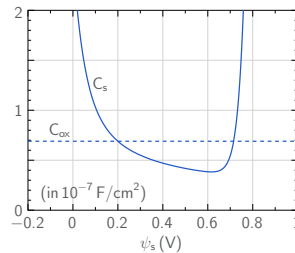
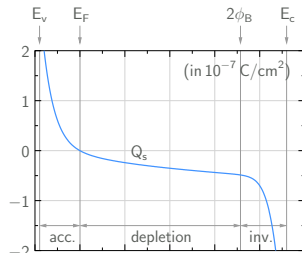
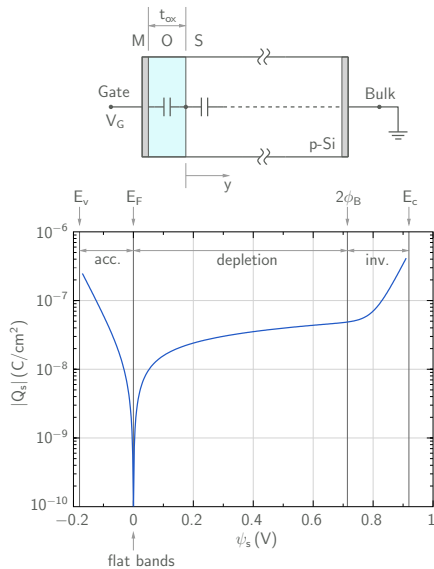


$$(N_a = 10^{16} \text{ cm}^{-3}, t_{ox} = 50 \text{ nm}, V_{FB} = 0 \text{ V}, T = 300 \text{ K})$$

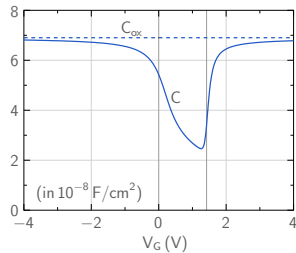
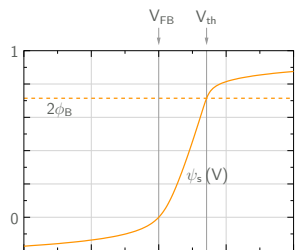


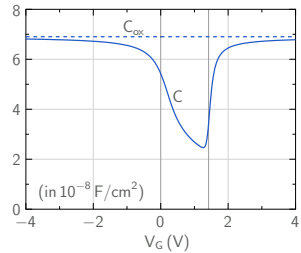
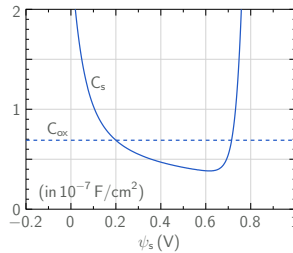
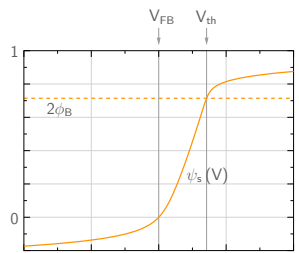
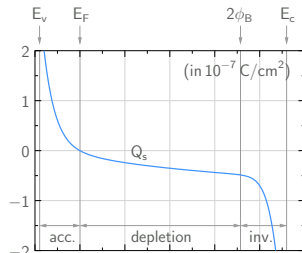
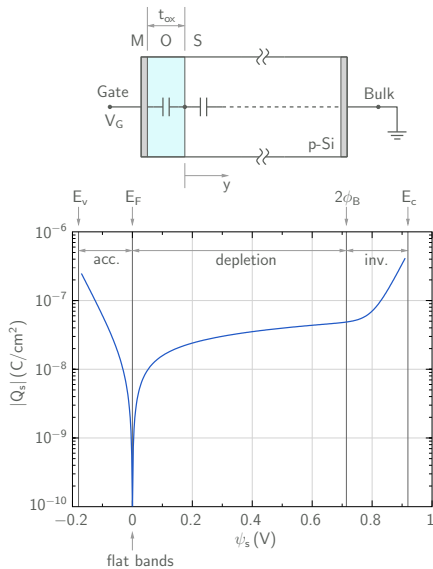
$(N_a = 10^{16} cm^{-3}, t_{ox} = 50 nm, V_{FB} = 0 V, T = 300 K)$

$$* Q_M = -Q_s \rightarrow C_s \equiv \frac{dQ_M}{d\psi_s} = -\frac{dQ_s}{d\psi_s}.$$



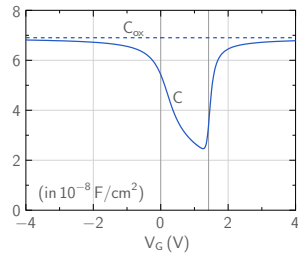
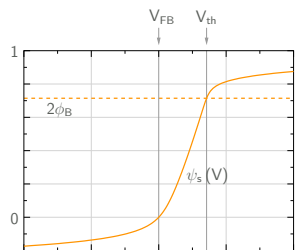
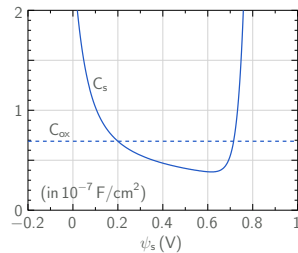
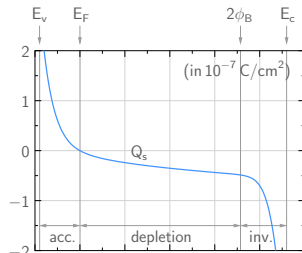
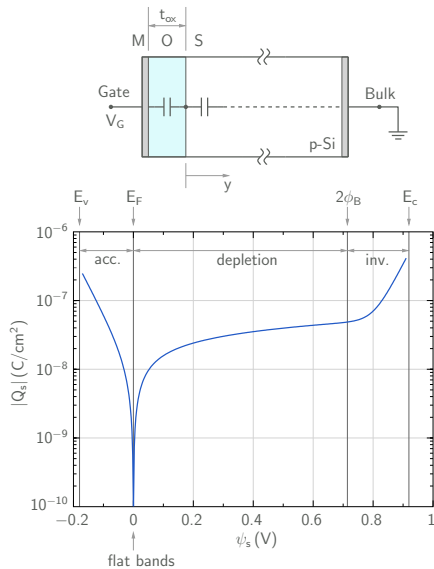
( $N_a = 10^{16}$  cm<sup>-3</sup>,  $t_{ox} = 50$  nm,  $V_{FB} = 0$  V,  $T = 300$  K)





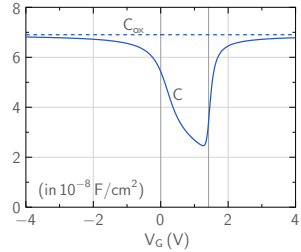
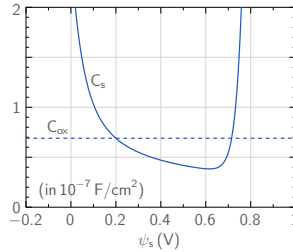
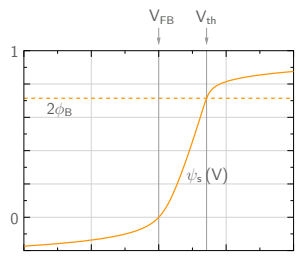
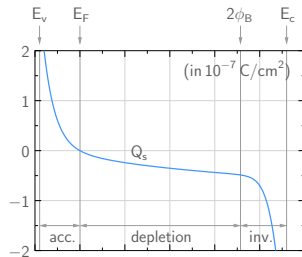
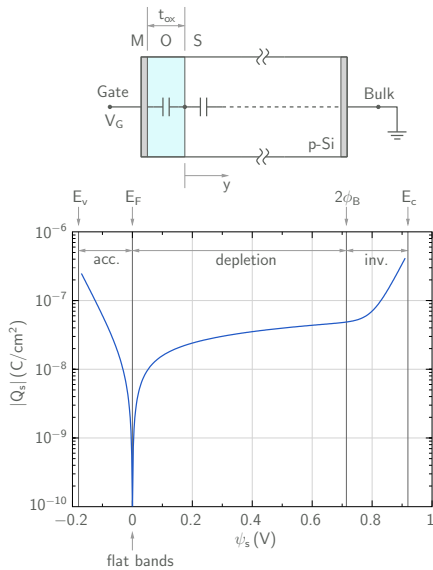
$(N_a = 10^{16} cm^{-3}, t_{ox} = 50 nm, V_{FB} = 0 V, T = 300 K)$

\* Accumulation and inversion:  $C_s$  is large compared to  $C_{ox}$ . Since  $\frac{1}{C} = \frac{1}{C_{ox}} + \frac{1}{C_s}$ ,  $C \rightarrow C_{ox}$ .



$$(N_a = 10^{16} \text{ cm}^{-3}, t_{ox} = 50 \text{ nm}, V_{FB} = 0 \text{ V}, T = 300 \text{ K})$$

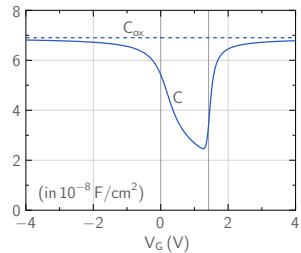
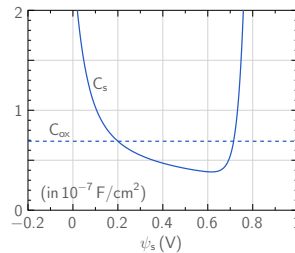
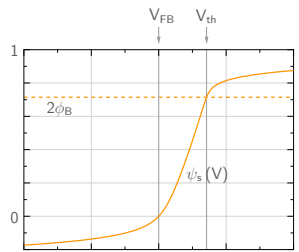
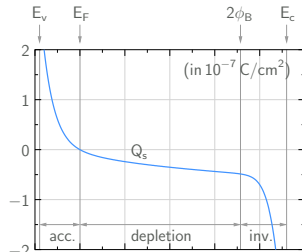
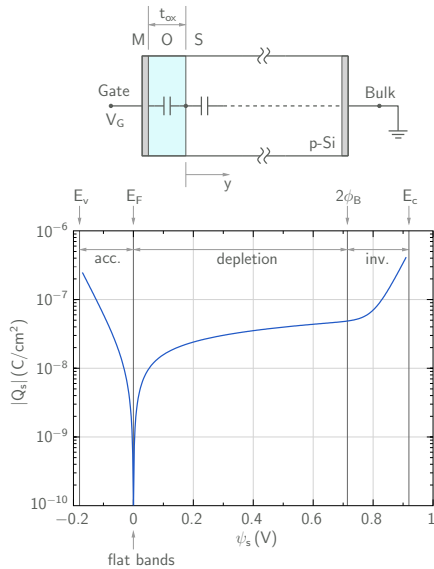




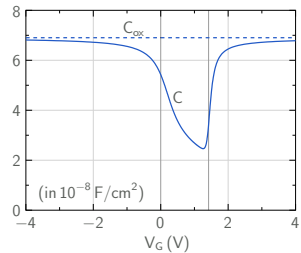
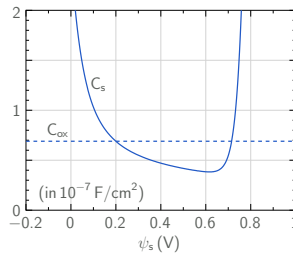
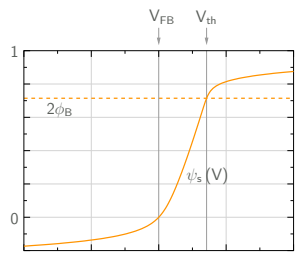
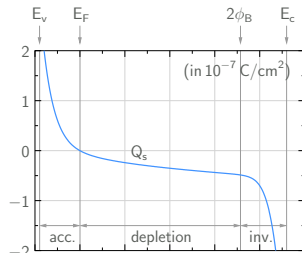
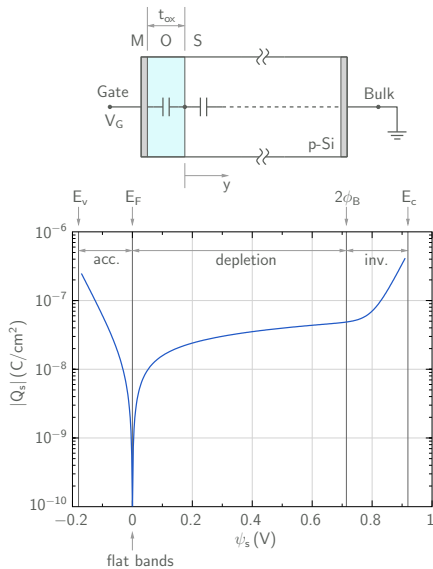
( $N_a = 10^{16} cm^{-3}$ ,  $t_{ox} = 50 nm$ ,  $V_{FB} = 0 V$ ,  $T = 300 K$ )

\* To map the surface potential  $\psi_s$  to the gate voltage  $V_G$ , we use

$$V_G = V_{FB} + \psi_s + \mathcal{E}_{ox} t_{ox} = V_{FB} + \psi_s + \frac{(-Q_s)}{\epsilon_{ox}} t_{ox} = V_{FB} + \psi_s + \frac{(-Q_s)}{C_{ox}}.$$

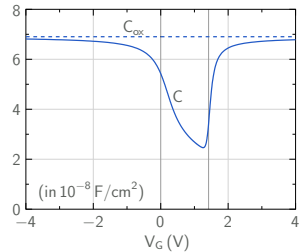
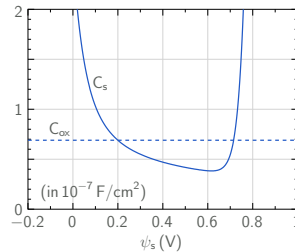
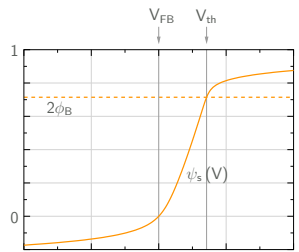
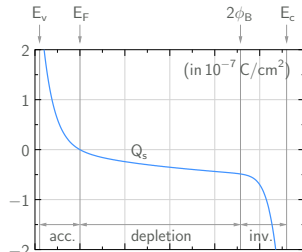
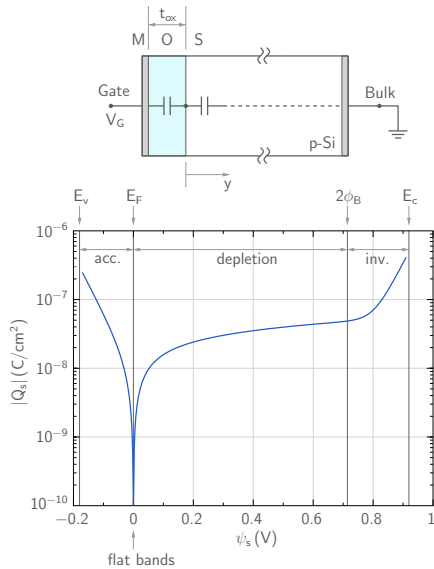


$$(N_a = 10^{16} \text{ cm}^{-3}, t_{ox} = 50 \text{ nm}, V_{FB} = 0 \text{ V}, T = 300 \text{ K})$$

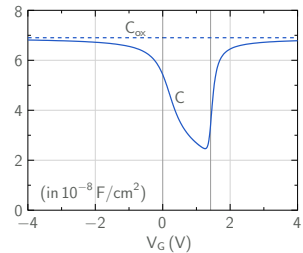
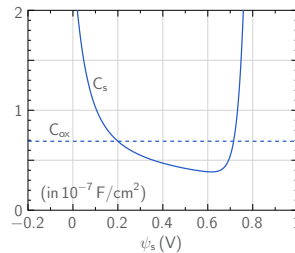
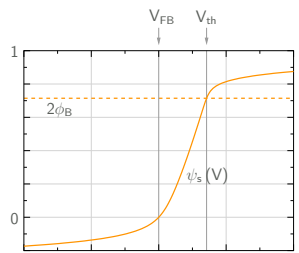
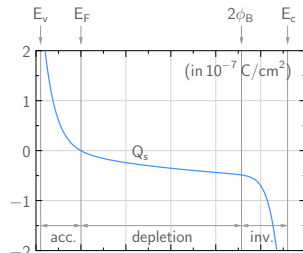
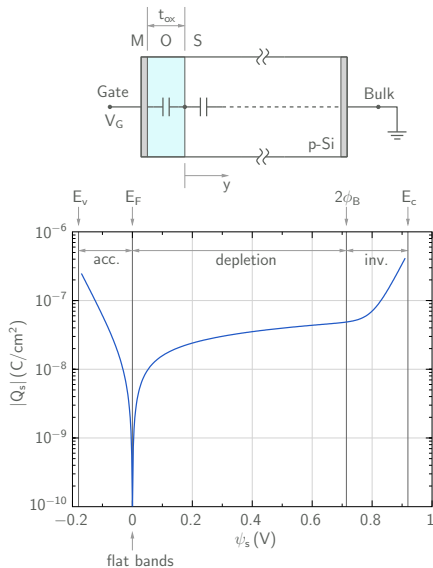


$$(N_a = 10^{16} \text{ cm}^{-3}, t_{ox} = 50 \text{ nm}, V_{FB} = 0 \text{ V}, T = 300 \text{ K})$$

\* In accumulation and inversion,  $C \rightarrow C_{ox}$ .

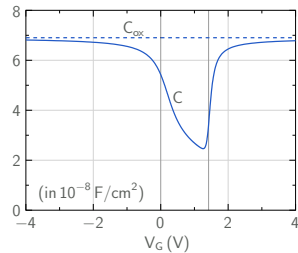
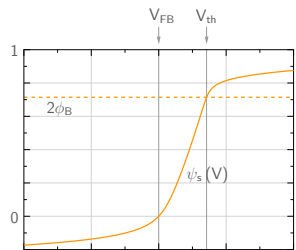
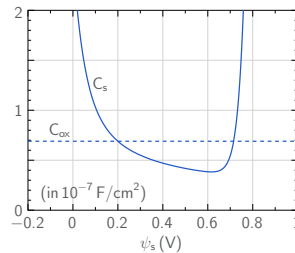
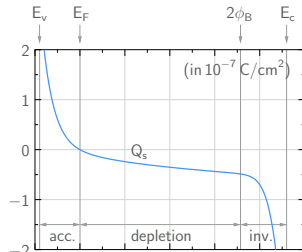
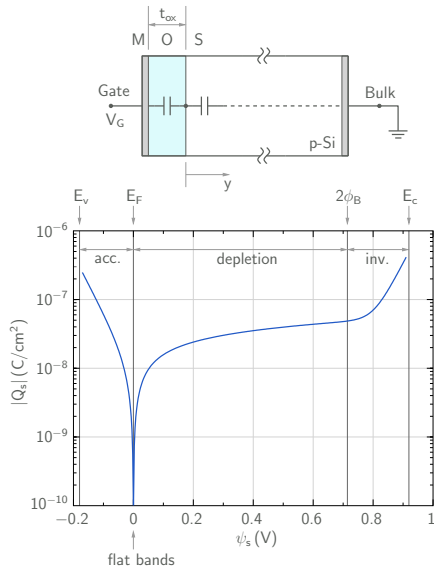


$$(N_a = 10^{16} \text{ cm}^{-3}, t_{ox} = 50 \text{ nm}, V_{FB} = 0 \text{ V}, T = 300 \text{ K})$$

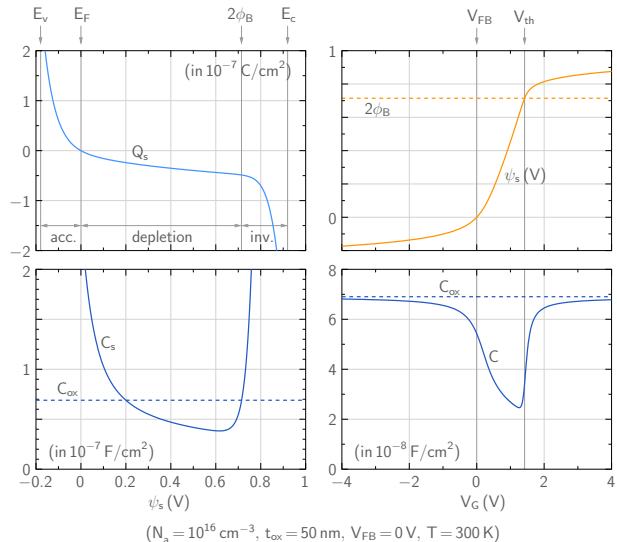
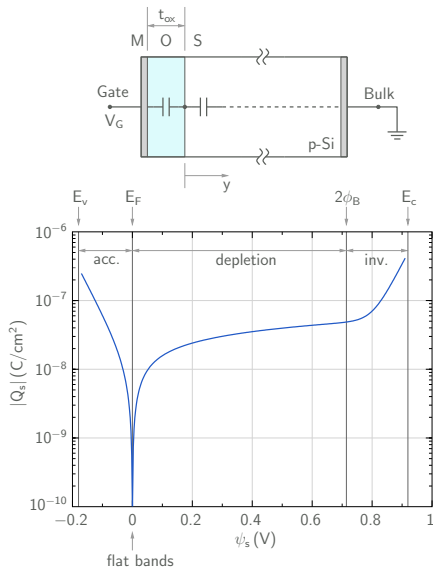


( $N_a = 10^{16} \text{ cm}^{-3}$ ,  $t_{ox} = 50 \text{ nm}$ ,  $V_{FB} = 0 \text{ V}$ ,  $T = 300 \text{ K}$ )

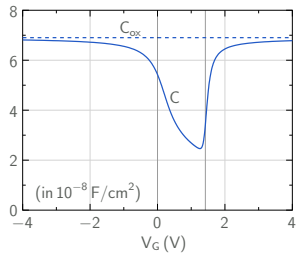
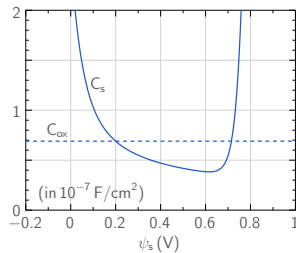
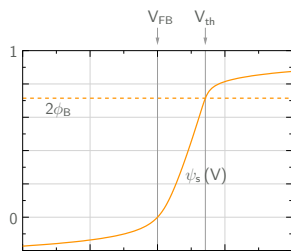
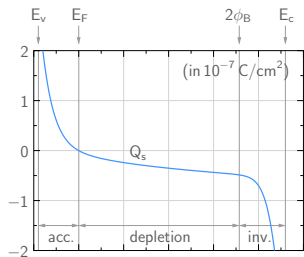
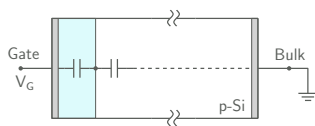
- \* In depletion,  $C$  is smaller than  $C_{ox}$  and is minimum when  $C_s$  is minimum. This corresponds to the situation where there is no inversion charge yet, but the depletion width has reached its maximum value which happens at the onset of inversion, i.e.,  $V_G \approx V_{th}$ .



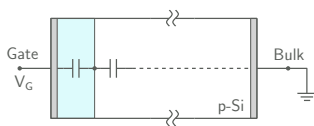
$$(N_a = 10^{16} \text{ cm}^{-3}, t_{ox} = 50 \text{ nm}, V_{FB} = 0 \text{ V}, T = 300 \text{ K})$$



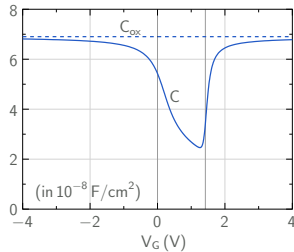
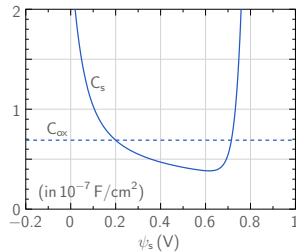
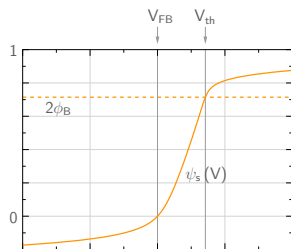
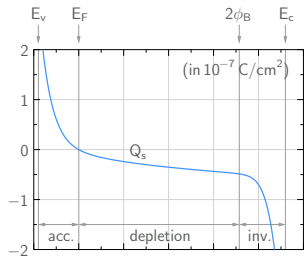
\* Since  $V_G = V_{FB} + \psi_s + \mathcal{E}_{ox} t_{ox}$ , a change in  $V_{FB}$  by  $\Delta V_{FB}$  causes the  $C$ - $V$  curve to shift horizontally by  $\Delta V_{FB}$ .

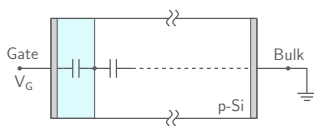




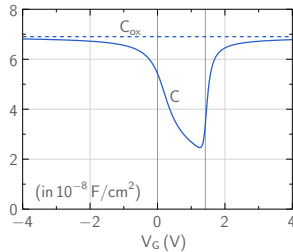
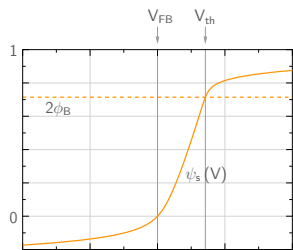
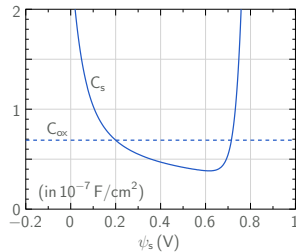
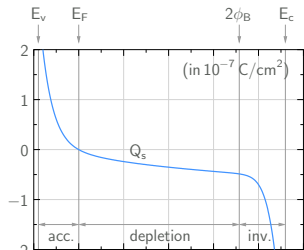


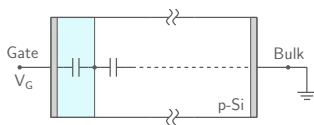
- \* We have assumed so far that the variation in the gate voltage is slow enough for the carriers to respond.



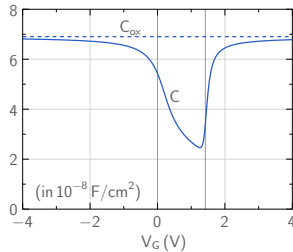
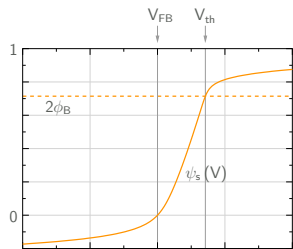
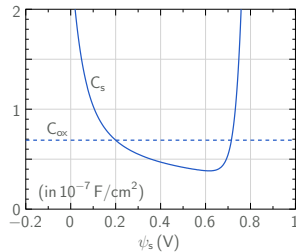
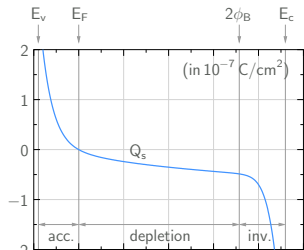


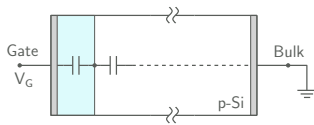
- \* We have assumed so far that the variation in the gate voltage is slow enough for the carriers to respond.
- \* The  $C-V$  measurement is made by applying  $v_G(t) = V_G + v_g \sin \omega t$ . We require  $f < 100$  Hz for the above assumption to hold.



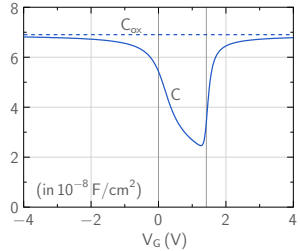
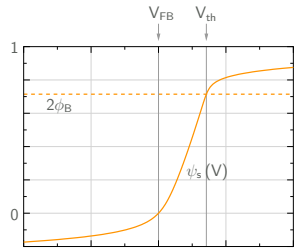
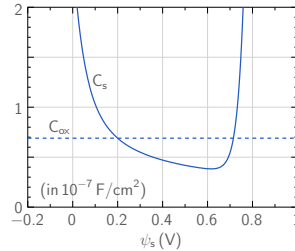
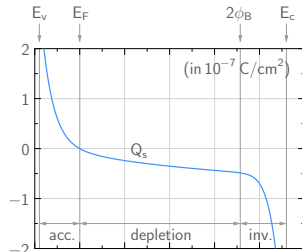


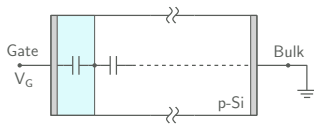
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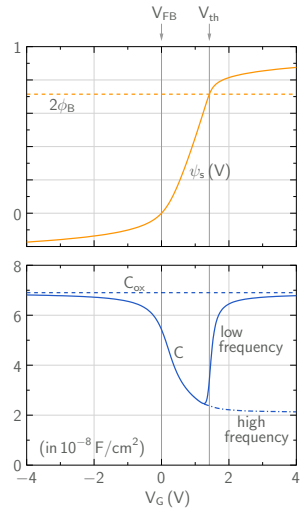
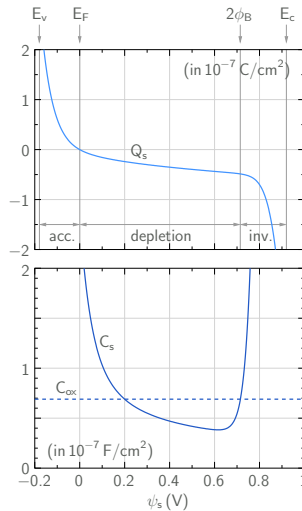


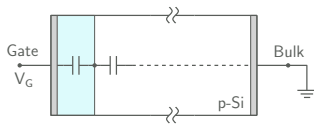
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- \* The low-frequency ( $f < 100$  Hz) and high-freq ( $f > 1$  MHz)  $C$ - $V$  curves offer an excellent “diagnostic” tool during processing since they can be used to find the oxide thickness, flat-band voltage, etc.

